E.G.S. PILLAY ENGINEERINGCOLLEGE

(Autonomous)

Approved by AICTE, New Delhi|Affiliated to AnnaUniversity, Chennai Accredited by NAAC with "A"Grade|Accredited by NBA (CSE, EEE, MECH)

NAGAPATTINAM—611002



B.E. Electronics and Communication Engineering

Full Time Curriculum and Syllabus

Final Year-Seventh Semester

Course	CourseName	T	T	P	C	Max	imum	Marks
Code	Courselvame	L	1	P	· ·	CA	ES	Total
Theory Coun	rse							
1702EC701	Microwave Engineering	2	0	0	2	40	60	100
1702EC702	Optical Communication	. 3	0	0	3	40	60	100
1702EC703	Wireless Communication	3	0	0	3	40	60	100
1702EC704	Image Processing	3	0	0	3	40	60	100
	Professional (Open)Elective – V	3	0	0	3	40	60	100
	Professional Elective – VI	3	0	0	3	40	60	100
LaboratoryC	Course		1					
1702EC751	Microwave and Optical Communication Laboratory	0	0	2	1	50	50	100
1702EC752	Mini Project	0	0	0	1-	100	-	100
1704EC753	In-plant Training/ Internship Presentation	0	0	0	1	100	-	100
1704GE751	Life Skills: Competitive Exams Preparation	2	0	0	2	100	-	100
	T	otai 20	0	6	24	640	460	1100
Professional Ele	ective - V					·		
1703MG701	Principles of Management	3	0	0	3	40	60	100
1703MG702	Disaster Management	3	0	0	3	40	60	100
1703MG703	Total Quality Management	3	0	0	3	40	60	100

. 1703MG704	Industrial Ec				3	0	0				0	100	
1702EC701	_ _	M	ICROWAVE	ENGIN	EER	ING				L	T	P	C
										3	0	0	3
Course Objective	es:												
	1.To gain	knowledge abou	it RF Electroni	ics.									
	2. To stud	y about the vario	ous microwave	compon	ent,	signa	l gen	erator	s and a	mpli	fiers.		
	3. To gain	knowledge abo	ut integrated c	ircuits an	ıd mi	crow	ave n	neaur	ements				
Unit I	INTROD	UCTION TO R	FFIFCTDO	NICS		-						9 H	
The Electromagne					ave	band	s. RF	beha	vior o	f Pass	sive (
Tuned resonant c Fransformers.	ircuits, Vector	s, Inductors and	d Capacitors.	Voltage	and	Curre	ent ir	cap	acitor	circu	its, T	uned F	RF/I
Unit II	MICROV	AVE COMPO	NENTS							-		9 H	OUI
ntroduction to M	lic towaves and	their application	ons, Coaxial I	Line Con	npon	ents,	Wav	e-gui	de Co	mpon	ents,	Direct	ion
Couplers, Hybrid	Tee Junction, J	Magic Tee, Atte	nuators, Ferri	te Device	es, Is	olato	rs, C	ircula	tors, C	avity	Res	onators	, R
entrant Cavities, V	0					-							
Unit III	MICRON	AVE SIGNAL	GENERATO	ORS AN	DAI	MPL	IFIE	RS				9 H	oui
Vacuum Tube Tri	iodes Resonar	t Cavity Davic	ac Defley VI	ictron T	1110	Covi	+ V	lvatno	n M.	1+;	Covi	6. Vl	+++-
Slow – Wave De	vices, TWT, C	rossed Field D	evices. Magne	etrons. Se	wo - emic	ondu	ty K. etor I	iysuo Devic	n, iviu es Mi	nı — crow.	cavi ave I	iy Kiys RITs F	ET
Tunnel Diodes, Gu	unn Diode, íMi	PATT, TRAPAT	TT Diodes.			01144		30110	00, 1111	01011	4,0 1	<i>,</i> 10, 1	
Unit IV	MICROV	AVE INTEGR		THITS	-					-		9 H	ΔIII
Unit IV Materials, Substra		AVE INTEGE Dielectric and R	RATED CIRC		IIC C	irow	h. Fa	.brica	tion Te	chnic	aues.	9 H MOSF	
Materials, Substra	te, Conductor,	Dielectric and R	RATED CIRC esistive Mater	rials, MM	IIC Cation.	Growt	h, Fa	brica	tion Te	chnic	ques,		
Materials, Substrate Fabrication, NMO	te, Conductor. S Growth and	Dielectric and R CMOS Develop	esistive Mater ment, Thin Fil	rials, MM	IIC Cation.	irowi	h, Fa	brica	tion Te	echnic	ques,	MOSF	ET
Materials, Substra Fabrication, NMO Unit V	te, Conductor, S Growth and MICROW	Dielectric and R CMOS Develon AVE MEASU	RATED CIRC esistive Mater ment, Thin Fil REMENTS	rials, MM Im Forma	ation.		h, Fa	brica	tion Te	echnic	ques,		ET
Materials, Substra Fabrication, NMO Unit V VSWR, Frequericy	te, Conductor, S Growth and MICROW y, Guide Wave	Dielectric and R CMOS Develon AVE MEASU	RATED CIRC esistive Mater ment, Thin Fil REMENTS	rials, MM Im Forma	ation.			brica [*]		echnic	ques,	MOSF	ET our
Materials, Substra Fabrication, NMO Unit V VSWR, Frequericy	te, Conductor, S Growth and MICROW y, Guide Wave	Dielectric and R CMOS Develop AVE MEASU ength, Coupling	esistive Mater ment, Thin Fil REMENTS and Directivi	rials, MM Im Forma ty measu	ation.					echnic	ques,	MOSF	ET our
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Materials, Substrate Fabrication, NMO Unit V VSWR, Frequency Further Reading:	te, Conductor, os Growth and MICROW, Guide Wave I. Recomplished Complete Co	Dielectric and RCMOS Develop AVE MEASU ength, Coupling ent wend in Mic eletion of the co about RF Electric the component	RATED CIRC esistive Mater ment, Thin Fil REMENTS and Directivi rowave applic rowave applic urse. Student v pnics. for microwave and amplifiers	ty measuration. ation. will be able applicates.	reme	ents				echnic	ques,	MOSF	ET our
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Materials, Substrate Fabrication, NMO Unit V VSWR, Frequency Further Reading: Course Outcomes References: 1703MG705	te, Conductor, PS Growth and MICROW, Guide Wave I. Recomplished I. Recomplished I. Explain: 2. Identify D. Discuss: 4. Illustrate 5. Explain Foundation Ski.	Dielectric and RCMOS Develop AVE MEASU ength, Coupling ent went in Mic oletion of the contout RF Electric the component ethe concept of	esistive Mater ment, Thin Fil REMENTS and Directivity and Directivity was student vonics. For microwave and amplifiers microwave in the measurement of the measuremen	ation. applicates. tegrated onts.	reme	ents				echnie 60		MOSF	ET our
Materials, Substrate Pabrication, NMO Juit V Journal of The Page 1985 Jurther Reading: Course Outcomes	te, Conductor, PS Growth and MICROW, Guide Wave I. Recomplished I. Recomplished I. Explain: 2. Identify D. Discuss: 4. Illustrate 5. Explain Foundation Ski.	Dielectric and RCMOS Develop AVE MEASU ength, Coupling ent wend in Mic bletion of the co about RF Electric the component ignal generator the concept of about microway	esistive Mater ment, Thin Fil REMENTS and Directivity and Directivity was student vonics. For microwave and amplifiers microwave in the measurement of the measuremen	ation. applicates. tegrated onts.	areme	ents		Total				9 H	ET Oui
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Materials, Substrate Pabrication, NMO Jnit V /SWR, Frequency Further Reading: Course Outcomes 1703MG705 Professional Ele 1703EC021	MICROW y, Guide Wavel 1.Recess: After complication of the control of the contro	Dielectric and RCMOS Develop AVE MEASU ength, Coupling ent werd in Mic pletion of the contact RF Electric the component enthe concept of about microway Is in Integrated Proceptial Signal Proception	RATED CIRC esistive Mater ment, Thin Fil REMENTS and Directivi rowave applic rowave applic urse. Student vonics. for microwave and amplifiers microwave in re measuremer educt Development essing	ation. applicates. tegrated onts.	arremed 200 li	ents its.	0	Total 3	40	60	0 0	9 H 45 H 100	ET oui
Materials, Substrate Fabrication, NMO Unit V VSWR, Frequency Further Reading: Course Outcomes References: 1703MG705 Professional ElectroseC021 1703EC022	MICROW y, Guide Wavel 1.Recess: After complication of the control of the contro	Dielectric and RCMOS Develop AVE MEASU ength, Coupling ent wend in Mic eletion of the co about RF Electric the component ingual generator e the concept of about microway Is in Integrated Price etter gital Signal Procestem nition and Mach	RATED CIRC esistive Mater ment, Thin Fil REMENTS and Directivi rowave applic rowave applic urse. Student vonics. for microwave and amplifiers microwave in re measuremer educt Development essing	ation. applicates. tegrated onts.	aremed by the state of the stat	its.	0 0 0	3 3 3	40 40 40	60	0 0 0 0 0 0 0	9 H 45 H 100 100	ET Oui
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 $L-Lecture |T-Tutorial| P-Practical| C-Credit| CA-Continuous Assessment| \ ES-End Semester$

Dr. S. RAMABALAN, M.E., Ph.D.,
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E.G.S. Pillay-Engineering College, Thethi, Nagore - 611 002. Nagapattinam (Dt) Tamil Nadu. Reinhold Ludwing, Pavel Bretchko, "RF Circuit design: Theory and applications", Pearson Education Asia Publication, New Delhi 2001.

 Secondations For Microwave Engineering, R. R. Collin, McGraw Hill
 Microwave Communications – Components and Circuits, E. Hund, McGrawHill.

 Microwave Devices and Circuits, S. Y. Liao, PHI.

 S.Microwave Engineering, R. Chatarjee, East – West Press Pvt. Ltd.

1702EC70	2	OPTICAL COMMUNICATION	L	T	P	C
			3	0	0	3
Course Ol	an Managarine and the company of the same of the company					
	 To lear structur 	in the basic elements of optical fiber transmission link, fiberes	r mode	s con	figura	tions and
		erstand the different kind of losses, signal distortion in optical ation factors. Design optimization of SM fibers, RI profile and o				
		n about various Optical Sources and Detectors.				
	 To Exp 	fore the trends of optical fiber measurement systems.				
	5. To Enri	ich the idea of optical fiber networks algorithm such as SONET	/SDH a	nd or	tical (CDMA
Unit 1	INTEGRI	CTION TO OPTICAL FIBERS) Hou	
			. 41			
internal re	floation Assume	System- Element of an Optical Fiber Transmission link Ray	/ ineory	ıran	SMISS	on- Total
propositio	n EM mous	ance angle Numerical aperture - Skew rays - Electromagn	etic mo	ae tr	eory	or optical
Index Sho	H -EM Waves -	-modes in Planar guide – phase and group velocity – cylindric	ai fibers	-5 _{IV}	Hiber	s- Gradec
Unit II		DEGRADATION OPTICAL FIBERS		(Hou	MC .
		losses. Scattering losses, Bending Losses, Core and Cladding	. 100000	-		
GI fibers-l	Mode Coupling - Expanded E	ion in SM fibers-Polarization Mode dispersion, Intermodal dispersion of the connectors, Fiber alignment and Joint Loss Connectors—Fiber Couplers SAND DETECTORS		ber :		s – Fibei
		nitting Diodes - LED structures - surface and edge emitters, i	mono or			
internal - efficiency	quantum efficie Resonant frequ	ency, lasers Diodes Modes and Threshold condition -Rate enterior injection laser diode structures. Photo detectors, Avalanche photo diodes, construction, ch	quations	-Ex	ternal	Quantum
Compariso	n of performan	ce. Photo defector noise -Noise sources. Signal to Noise ratio,	Detecto	r res	ponse	time.
Unit IV	FIBER OF	TIC RECEIVER AND MEASUREMENTS			Hou	
Fundamen		eration. Pre complifiers, Error sources - Receiver Configura	tion- Pr			
Quantum	limit Fiber A	ttenuation measurements- Dispersion measurements - Fibe	er Refr	active	e inde	ex profile
measureme	ents Fiber of	at off Wave length Measurements - Fiber Numerical Aper	rture M	easur	ement	s – Fibe
	eacurements					
Unit V	Committee of the Commit	NETWORKS AND SYSTEM TRANSMISSION /		(Hou	rs
Basic Netv	toks - SONE	/ SDH - Broadcast - and -select WDM Networks - Wavelen	oth Roi			
linear effe	ots on Natwo	rk performance - Link Power budget -Rise time budget-	Noise	Effe	cts o	n Creston
Parforman	on Consisting of	as contact entre - third interest printer -trise fille number-				II System
CHOMMAN	oe-Operation at	Principles of WDM Ferformance of WDM + EDFA system -	Soliton	s - O	ptical	CDMA –
Ultra High	Capacity Netw	Principles of WDM Ferformance of WDM + EDFA system – orks.	Solitons	s – O	ptical	CDMA -

Further Re	iding:				
-	Design Optimization of SM fibers-RI profile and cut-off wavelength.				_
	Fiber amplifiers- Power Launching and coupling, Lencing schemes				
Course Out	comes:	150	_		
	After completion of the course, Student will be able to	Sory			
	1. Discuss the various optical fiber modes, configurations.	- -			
	2. Demonstrate various signal degradation factors associated with optical fibe	er.			
	3. Classify various optical sources and optical detectors and their use in the o	ptical co	mmun	ication	1
	4. Explain Various Fiber Optic measurements.				_
	5. Calculate the digital transmission and its associated parameters on system	performa	ince.		
References:					
1. Gerd Keis	er. "Optical Fiber Cemmunication" Me Graw -Hill International, 4th Edition., 2	010.			
	enior, "Optical Fiber Communication", Second Edition, Pearson Education, 20		n	1	
3. Ramaswan	ni. Siyarajan and Sasaki "Cortical Narworks", Morgan Kaufmann, 2009	12	1		
4. J.Senior, "	Optical Communication, Principles and Practice", Prentice H.Dro S. BAMAB	ALOAN!	000	Dh B	
5. J.Gower,	Optical Communication System", Prentice Hall of India, 2001. PRIN	CIPAL			
1	E.G.S. Pillay Eng Thethi, Nag Naga pattinam	gineering ore - 611	002.		
1702EC703	WIRELESS COMMUNICATIONS	L	T	P	C
		3	0	0	3
	(Common to B E / B Tech = FCE / IT)				

•		· (we) runn	ii itadu		
1702EC703	WIRELESS COMMUNICATIONS	L	T	P	C
		3	0	0	3
	(Common to B.E / B. Tech – ECE, IT)				
Course Obje	ectives:				-li-
	1. To become skilled at fundamentals of mobile and wireless communications.	ation techr	nologie	s and	its
	applications.				
	2. To create the student to work on the transceivers for wireless channels				
Unit I	Introduction		Hours		
Introduction	to wireless Communication systems - Evolution of Mobile communicati	on system	-20	i, 3G,	4G,
UMTS, LTE,	WLL, WLAN, WPAN, Blude 15, Ultra Wide Band				
Unit II	Mobile Radio Propagation	10) Hou	'S	
Large scale	ath loss - Path loss in their F- Space and TwoRay models -Link Budget of	lesign –Sn	nall sc	ale fac	ding-
Parameters of	of mobile multipath channels -Time dispersion parameters-Coherence band	lwidth –D	oppler	sprea	ad &
Coherence tin	me, Fading deleto Multiput lime delayspread-flat fading				
	ective fading -Fading due to Doppler spread -fast fading -slow fading.				
Unit III	Cellular Communication	10	Hour	'S	
Introduction	Frequency 1966, Compassion ent techniques, Hand off Strategies, Interfer	ence and s	System	Capa	icity,
Trunking and	f Grade of Service, improving Coverage and capacity in cellular systems.M	Iultiple A	ccess t	echnic	ques:
FDMA, TDM	14, CDMA, SDMA				
Unit IV	Modulation Schemes and Spread Spectrum	12	2 Hou	·s	
Modulation t	echniques: M-QAM, M-PSK, GMSK, Spread Spectrum Systems: PN sequence	ce-m-sequ	ence		
-Direct Sequ	ence Spread Spectrum-Frequency Hopping Spread Spectrum, Synchronizate	tion techn	iques	for Sp	oread
Spectrum sig	nals. Diversity and Combining Techniques: Time Diversity, Frequency diversity	sity, Space	Diver	sity	
Unit V	Multiple Antenna Techniques	9	Hours		
MIMO syste	ns - spatial multiplexing - System model - Pre-coding - Beam forming - Spa	ce Time (Coding	Alan	nouti
scheme -Cha	mnel state information-composity in fading and non-fading channels- comb	ining tech	niaues	-Sele	ction
combining, E	qual gam combining. Maximum ratio Combining, RAKE receiver. Introducti	on to OFI	M		
				otal:	45
Further Rea	ding:				
	WANET, Ict. Zighe Technology, WiMax, WLAN				
Course Outc	OTHES				
	After completion of the course, Student will be able to				
	L. Characterize interference Letwern mobile and base stations				

2	 Apply the knowledge in understanding the allocation of the limited wire government regulatory agencies. 	eless spectrum by
	3. Predict the received signal through the multipath channel.	Entreprenn
- 1	4. Analyze and Evaluate receiver and transmitter diversity techniques.	1 9 9
	5. Analyze the multiple antenna techniques	V
References:		y
1. Rappapor	t. T.S., "Wireless Communications: Principles and Practices", Second Edition	PHI, 2014
2. Andrea G	oldsmith, "Wireless Communication", Cambridge University Press, 2005	
	"Molisch "" Treless Communications", John Wiley, 2010	
4. John G. P	roakis, "Digital Communication" McGraw Hill, 4th Edition, 2008	
	Stuber. "Principles of Mabile Communication", 3rd Edition, Springer Internation	onal Ltd.,2011
	Lee, "Wireless and Cellular Communications District McGraw Hill, 2000	

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	Nagapattinam (Dt) Tamil Nadu.				
1702EC704	IMAGE PROCESSING	L	Т	P	C
		3	0	0	3
	(Common to ECE/CSE/IT)				
Course Object					
	1. To make the students to understand the digital image fundamentals.				
	2. To study the digital image using different transforms.				
	3. To acquire the basic knowledge in filters, image enhancement, image	restora	tion a	nd	
	compression techniques.				-
Unit I	DIGITAL I WAGE FUNDAMENTALS			9 F	lours
Elements of d	igital image processing systems, Elements of visual perception, Image sampling	g andqı	ıantiz	ation,	Basic
	between pixels. Image Transforms: Discrete Fourier transform, Cosine, Hadai				
Slant transfor	District Control of the Control of t				
Unit II	IMAGE ANALYSIS			9 F	lours
Histogram	cessing her live and ispecification techniques, Basics of spatial filtering, Sr	noothi	ng		
	Sharpening spatial filters Image smoothing and sharpening using frequency do	main f	ilters.		
Unit III	IMAGE SEGMENTATION			9 F	four
multivariacio:	roundary detection. Thresholding-basic global thresholding, Otsu's method, diresholding. Region-based segmentation-Region growing, Regionsplitting and	mergii	ie, v ig.		
	IMAGE RESTORATION AND RECOGNITION				lours
	ation/restoution model. Noise models, Restoration-Spatial Filtering, Constrain				
	ng. Wiener Filtering. Object recognition-Patterns and patternclasses, Match ural networks-Background. Training by Back Propagation.	ing-M	nımu	m Dis	tance
	MAGE COMPRESSION			0 F	lours
	Basic persons sign methods-Huthaan coding, Golomb coding, Arithmetic cod	ing L	7 \ \ /		iours
coding, Run	length coding, Lossless and Lossy predictive coding, Block transform coding,	Wavele	etcodi	ng.	
	Total:			45 H	lours
Further Read					
KL	transform and their properties. Homemorphic filtering, Morphological image p	rocess	ing – I	Erosio	n and
Dila	ation. Opening and closing Segmentation using morphological watersheds,	Applie	cation	s of r	neura
net	vorks in image processing, Digital image watermarking.				
Course Outco	DMOST		17	_	
	omes: Example tion of the course, Student will be able to	WI.	MA	A	127 - 2
7310	Analyze the image using image transforms.			-	
	Develop a methodology for smoothening and sharpening of the image			/	
	and sharpening of the image				

3. Segment the image using edge detection, thresholding and region based approach.
4. Develop a method to restore the image and object recognition
5. Compress the image using lossy and lossless compression techniques.

References:
1. C.Rafeal Gonzalez and E.Richard Woods, Digital Image Processing, Third Edition, Pearson Education 2008.
2. Anil K.Jain, Fundamentals of Digital Image Processing, PHI, 2010.
3. S Jayaraman, S Esakkirajan T Veerakumar, Digital Image Processing, Mc Graw-Hill, 2010
4. K.William Pratt, Digital Image Processing, John Wiley, 1997.
5. M.A.Sid Ahmed, Image Processing Theory, Algorithm and Architectures and Graw - Hill, 1995.

Dr. S. RAMABALAN, M. Ph.D.,

	E.G.S. Pillay Engineering College,				
1702EC751	MERCHARDINA DESCRIPTION OF THE PROPERTY OF THE	L	T	P	(
	Nagapattinam (Dt) Tamil Nadu.	0	0	4	2
Course Objects	1227a. a				
	 To have a detailed practical study on microwave equipments and microwave 	ostrip cor	npon	ents.	
	 To study the optical devices and to use in appropriate application. 				
List of Experim	ents:				
	EXPERIMENTS:				
	on – Mode characteristics				
2. Gunn Diode –	The state of the s				
	ency and Wave Length Measurement	i.			
	publer - Directivity and Coupling Coefficient - S - parameter				
Measurement					
	- parameter measurement				
	d Power measurement				
	racterization of L-Plane T, H-Plane T and Magic T.				
8. Radiation Paπ	em of Artichaes				
9. Antenna Gain	ivieusure (nept)				
OPTICAL EXP					_
1. DC characteris	sties of LED and FIN Photo Diode.				
Mode Charact					
3. Measurement	of Connector and Bending Losses.				
 Fiber Optic An 	nalog and Digira, Link				
	tature Determination for Fibers			7	
6. Attenuation M	eastrement in Pibers.				
Contend be	syundt				
	f Manchester coding.				
- 01114	Turning Journey	Total:	45	Hou	rc
Course Outcom	pç.	I Utal.	*10	1100	13
	fter completion of the course. Student will be able to				
/1.	And the second s				_
	1. Apie to study and analyze microwave equipments.				
	2. Able to study and analyze optical devices.				

1703MG001	PRINCIPLES OF MANAGEMENT	L	T	P	С
7		3	0	0	3
Course Objectives					
Course Objectives:					
2. To study i	the students to study the evolution of Management the functions and principles of management the application of the principles in an organization	1			
Unit I INTRODU	CTION TO MANAGEMENT AND ORGANIZATIONS			9 H	ours
Definition of Management skills – Evolution of Mana Business organization –	- Science or Art - Manager Vs Entrepreneur - Types of manager verment - Scientific. Human relations, System and contingency Sole proprietorship, partnership, Company-public and privary vironment - Current trends and issues in Management.	approa	ches -	l roles - Type	and es of
Unit II PLANNIN	G			9 H	ours
	sing — Planning Process — Types of planning — Objectives — Sett egic Management — Planning Tools and Techniques — Decision m			_	
Unit III ORGANIS	ING			9 H	ours
Line and staff authority - I Design - Human Resource	pul and informal organization — Organization chart — Organization of authority — Centralization and Management — HR Planning, Recruitment, Selection, Train. Career planning and Management.	d Decen	traliz	ation -	- Job
Unit IV DIRECTH					ours
satisfaction - Job enrichm	and Group behaviour – Motivation – Motivation theories – Motivation – Leadership – Types and theories of leadership – Communication – Effective communication – Communication and	nunicati		-	
Unit V CONTROL	JING			9 H	ours
	trolling - Budgetary and non-budgetary control techniques - Use ductivity problems and management - Control and performance				
The state of the s	Total	:		45 H	ours
Further Reading:	cision roles of managers.				
	Crational thoughts.	-			
Course Outcomes.					
	letion of the course, Student will be able to				
	plain the elements of Management and Organization.	rio-kan sesenan	- 9		
	numarize the types, policies, tools and techniques in Planning in Marke the job design and human resource management in Organizing		ent	11	
4. Ht	strate the skills of leadership and communication				
	erprof the controlling techniques in Management				
References: 1. Stephen A. Robbin	as & David A. Decenzo & Mary Coulter, "Fundamentals of Mana	zement"	7 th 1	Edition	1.
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3. Robert Kreitner &:	Marnata Mohapatra, "Management", Biztantra, 2008.				

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1703MG@02	DISASTER MANAGEMENT	L	T	P	C
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Course Objectives:					
1 T	17 17 17 17 17 17 17 17 17 17 17 17 17 1				
	exposure to disasters, their significance and types. I the relationship between vulnerability, disasters, disaster prevention an	ad rick	roduc	tion	
	diminary understanding of approaches of Disaster Risk Reduction (DRR)		reduc	uon	
	The state of the s	.)			
The second section is a second	ODUCTION TO DISASTERS				lour
	Hazerd, Vulnerability, Resilience, Risks - Disasters: Types of d				
	rought. Fire etc - Classification, Causes, Impacts including socia				
environmental, health	, psychosocial, etc Differential impacts- in terms of caste, class,	gend	ler, ag	e, loc	ation
	on'ts during various types of Disesters.				
	OACHES TO DISASTER RISK REDUCTION (DRR)				lour:
	uses, Culture of safety, prevention, mitigation and preparedness co				
	ral measures, Roles and responsibilities of community, Panchayati LBs LStates, Centre, and other stakeholders-State Disaster Manageme				
	i - Advisories from Appropriate Agencies	em At	unom	y(3DIV	1A)-
	R-RELATIONSHIP BETWEEN DISASTERS AND DEVELOPME				
		NT		9 H	lours
Factors affecting Vuln			ns. em		lours nents
	erabilities, differential impacts, impact of Development projects such a	as dar		bankn	nents
changes in Land-use		as dar		bankn	nents
changes in Land-use Relevance of india Unit IV DEMAS	rerabilities, differential impacts, impact of Development projects such a etc.—Climate Change Adaptation-IPCC Scenario and Scenarios in the knowledge comportate technology and local resources. STER RISK MANAGEMENT IN INDIA	as dar	ontext	bankn of In	nents dia - lour:
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changes in Land-use Relevance of indiagram Unit IV DEMS Hazard and Waste Management 1	rerabilities, differential impacts, impact of Development projects such a set of Climate Change Adaptation-IPCC Scenario and Scenarios in a knowledge toppopriate technology and local resources. STER RESIGMANAGEMENT IN INDIA His profits of India Components of Disaster Relief: Water, Food, San and it tions along monts (Mitigation, Response and Preparedness, Disaster).	as dan the conitation	n, Shel	bankn of In 9 H Iter, H gemen	dia - lour ealth
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Refer	rences:
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PRINCIPAL

E.G.S. Pillay Engineering College,
Thethi, Nagore - 611 002.
Nagapattinam (Dt) Tamil Nadu.

1703MG0@5	TOTAL QUALITY MANAGEMENT L	T	T	P	С
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Course Obligation					
Course Objectives:					
To lear	n concepts, dimension quality and philosophies of TQM.				
To stud	dy the TQM principles and its strategies.				
3 To my	as knowledge on TQM roots for continuous improvement.				5
Unit I INTRO	POUCTION			9 H	lours
Definition of Guainy	Dimensions of Quality - Quality Planning - Quality costs - Analysis Tech	hni	anes		
Costs - Basic concepts of	of Total Quality Management - Historical Review - Quality Statements -	Str	rateoi	c Plan	ning
Deming Philosophy - (Chosby philosophy - Continuous Process Improvement - JuranTrilogy,	PΙ	DSA	Cycle	58
Kaizen - Obstacles to To	OM implementation		0071	Cycle	, 50
	RINCIPLES	T		0.11	_
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		ton	ner sa		
Principles of EGM Lea	dership - Concepts - Role of Senior Management - Quality Council, Cus	ton	ner sa	tisfac	tion -
Principles of TGM Lea Customer Perception	dership - Concepts - Role of Senior Management - Quality Council, Cus of Quality, Customer Complaints, Service Quality, Customer Re	ten	tion,	tisfac Emp	tion loyee
Principles of TQM, Lea Customer Perception Involvement - Motivati	dership - Concepts - Role of Senior Management - Quality Council, Cus of Quality, Customer Complaints, Service Quality, Customer Recons. Empowerment. Teams, Recognition and Reward, Performance Ap	ten opr	tion, aisal,	tisfac Emp Bene	tion loye fits
Principles of TOM Lea Customer Perception Involvement - Motivata Supplier Partnership -	dership - Concepts - Role of Senior Management - Quality Council, Cus of Ouality, Customer Complaints, Service Quality, Customer Remon. Empowerment. Teams, Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations	ten opr	tion, aisal,	tisfac Emp Bene	tion loye fits
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Principles of TQM, Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATIS	dership - Concepts - Role of Senior Management - Quality Council, Cus of Quality. Customer Complaints, Service Quality, Customer Recons. Empowerment. Teams, Recognition and Reward, Performance Appropriate Sourcing, Supplier Selection, Supplier Rating, Relations Basic Concepts, Strategy, Performance Measure SELCAL PROCESS CONTROL (SPC)	ten opra ship	tion, aisal, p De	Emp Emp Bene velopi	tion loyed fits ment
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Principles of TQM, Lea Customer Perception Involvement - Motivati Supplier Partnership - Performance Measures - Unit III STATIS The seven tools of quali Sample, Normal Curve.	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality, Customer Complaints, Service Quality, Customer Remon. Empowerment. Teams, Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations - Basic Concepts, Strategy, Performance Measure STICAL PROCESS CONTROL (SPC) 13 Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NF	ten opra ship ion	tion, aisal, p De	Emp Bene velopi	tion loyed fits ment lours
Principles of TQM. Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATE The seven tools of quali Sample, Normal Curve, Industrial Examples	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality, Customer Complaints, Service Quality, Customer Reson. Empowerment. Teams. Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations Basic Concepts. Strategy, Performance Measure SELCAL PROCESS CONTROL (SPC) 15 Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NE	ten opra ship ion	tion, aisal, p De n, Pop C, an	tisfact Emp Bene velopi 9 H ulation d u cl	tion loyed fits ment lours n and harts
Principles of TQM. Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATE The seven tools of quali Sample, Normal Curve, Industrial Examples, Month IV TQM T	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality, Customer Complaints, Service Quality, Customer Resion. Empowerment. Teams, Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations Basic Concepts, Strategy, Performance Measure STICAL PROCESS CONTROL (SPC) 13 Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NE	ten oprashij ion	tion, aisal, p De n, Pop C, an	Emp Bene Velopi 9 H ulation d u cl	loyee fits - ment fours n and harts
Principles of TQM, Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATE The seven tools of qualification of Sample, Normal Curve, Industrial Examples, Industrial	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality. Customer Complaints, Service Quality, Customer Remon. Empowerment. Teams. Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations Basic Concepts. Strategy, Performance Measure STICAL PROCESS CONTROL (SPC) 1. Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NECCES CONTROL (SPC) 1. Concept of six sigma - New seven Management tools COLS 1. Benchmark - Benchmarking Process, Quality Function Deployments	ten oproshij ion ont(((tion, aisal, p De n, Pop C, an	Emp Bene Velopo 9 H ulation d u cl	tion loyed fits ment lours n and harts
Principles of TQM. Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATIS The seven tools of quality Sample, Normal Curve, Industrial Examples, Process, Unit IV TQM T Benchmarking - Reason Quality, OFD Process,	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality, Customer Complaints, Service Quality, Customer Reson. Empowerment. Teams, Recognition and Reward, Performance Applications, Supplier Selection, Supplier Rating, Relations, Basic Concepts, Strategy, Performance Measure SELCAL PROCESS CONTROL (SPC) 1. Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NE Control Charts for variables X bar and R chart and attributes P, NE Concept of six sigma - New seven Management tools GOLS 1. Senchmark - Benchmarking Process, Quality Function Deployment and Benefits - Taguchi Quality Loss Function - Total Productive Ma	ten oproshij ion ont(((tion, aisal, p De n, Pop C, an	Emp Bene Velopo 9 H ulation d u cl	tion loyed fits ment lours harts
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Principles of TQM. Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III STATE THE Sample, Normal Curve, Industrial Examples, Monti IV TQM T Benchmarking - Reason Quality, OFD Process, Concept, Improvement Unit V QUAL Concept, Requirements	Gership - Concepts - Role of Senior Management - Quality Council, Custor Ouality, Customer Complaints, Service Quality, Customer Remon. Empowerment. Teams, Recognition and Reward, Performance Apparatering, sourcing, Supplier Selection, Supplier Rating, Relations Basic Concepts, Strategy, Performance Measure STICAL PROCESS CONTROL (SPC) If Statistical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NECOS CONTROL STATES FOR VARIABLE STATES AND SENDENCE OF SIX Sigma - New seven Management tools GOLS Is to Benchmark - Benchmarking Process, Quality Function Deployment and Benefits - Taguchi Quality Loss Function - Total Productive Management STATEMS of ISO 9000 and Other Quality Systems - ISO 9000:2000 Quality S	ion iont(((inte	tion, aisal, p De n, Pop C, an QFD) enanc	Emp Bene Velopo 9 H ulation d u cl 9 H - House (TP	tion loyee fits ment lours n and harts lours of M) lours nents.
Principles of TQM. Lea Customer Perception Involvement - Motivate Supplier Partnership - Performance Measures - Unit III	dership - Concepts - Role of Senior Management - Quality Council, Custoff Ouality, Customer Complaints, Service Quality, Customer Reson. Empowerment. Teams, Recognition and Reward, Performance Applications, Supplier Selection, Supplier Rating, Relations - Basic Concepts, Strategy, Performance Measure STICAL PROCESS CONTROL (SPC) L. Stanstical Fundamentals - Measures of central Tendency and Dispers, Control Charts for variables X bar and R chart and attributes P, NF cascapability, Concept of six sigma - New seven Management tools GOLS 15 Benchmark - Benchmarking Process, Quality Function Deployment and Benefits - Taguchi Quality Loss Function - Total Productive Management Meds, and FMFA - Stages of FMEA- Casestudies TOTAL STEMS 15 150 9000 and Other Quality Systems - ISO 9000:2000 Quality Sith System, Documentation, Quality Auditing, ISO 9000:2005 and 9001:20	ion iont(((inte	tion, aisal, p De n, Pop C, an QFD) enanc	Emp Bene Velopo 9 H ulation d u cl 9 H - House (TP 9 H Elem 0 1400	tion loyed fits ment lours n and harts lours of M) lours nents nents lours nents nents lours nents lours nents lours nents lours nents nents lours nents lours nents nents lours nents nents lours nents nents nents lours nents nen
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,	After completion of the course, Student will be able to
	1. Understand the concepts, dimension quality and philosophies of TQM.
	2. Understand the principles of TQM and its strategies.
	3. Apply seven statistical quality and management tools
	4. Understand TQM tools for continuous improvement.
	5 Understand the QMS and EMS
References	
1.	Rathakrishnan, Gas Dynamics, 5th edition, PHI Learing Private Limited, 2013.
2.	N. Gupta and B. Valarmathi, Total Quality Management, Tata McGraw-Hill Publishing Company Pvt. Ltd., New Delni, 2009.
3.	S. Komar, Total Quality Management, Laxmi Publications Ltd. New Delhi, 2006
4,	P.N. Muherjee, Total Quality Management, Prentice Hall of India, New Delhi, 2006.
5.	Dale H. Besterfited. Total Quality Management, Pearson Education Inc., New Delhi, 2003.
6.	James R. Evans and William M. Lidsay, The Management and Control of Quality, South- Western2002

1703MG006	NEUSTRIAL ECONOMICS	L	Т	Р	С
		3	0	0	3
Course Objectives:					
 To introduce the control industry. 	cepts of micro, macroeconomic systems and bu	siness decision	ns in		
2. To acquire knowledge	on laws of demand & supply and methods of foreca	sting thedema	nd		
3. To emphasis the syste	matic evaluation of the costs, breakeven point for r	eturn on econo	mics		
and disaconomics	,				
Unit I INTRODUCT	1014				9 Hours
Introduction to industrial eco	nomics wifere and Macro economics - Kinds of	Economic Sy	stems	- Pro	duction
Possibility Frontier - Opportun	ny Cost - Objective of Organizations - Kinds of Org	anization.			
Unit II DEMAND AN	DSUPPLY				9 Hours
Functions of Demand and Sup	ply - Law of diminishing Marginal Utility - Law of	f Demand and	Suppl		
Demand - Demand Forecasting	Methods - highfierence curve.		o orpp.)	
Unit III PRODUCTIO				(9 Hours
	to Scale Law of Variable Proportion - Cost and Re	evenue concen	ts and		
Revenue curves - Economics a	of Dis-Economies of scale - Break Even point.	- · · · · · · · · · · · · · · · · · · ·			
Unit IV MARKET ST				(9 Hours
Market Structure - Pendent Lon	specition - Monopoly - Monopolistic - Oligopoly - C	Components of	Prici		
Pricing - Capita, Euggeting II	R - ARR 1127 - Return on Investment - Payback P	eriod.	1 1101		
Unit V INTRODUCT	ION TO MACRO ECONOMICS AND FINANC	IAL	1		9 Hours
ACCOUNTIN					, iiouib
National Income - Calcula lo-	Methods - Problems - Inflation - Deflation - Bus	siness Cycle -	Taxe	s - Di	rect and
Indirect Taxes - Fiscal and mo					
	F1	Total:		45	Hours
Further Reading:					
100	ture and the seterinics of Indian Economy				
	le and functions of Control bank - LPG - GATT - WTG	0.			
Course Outcomes:					
After completion	m of the course, Stadent will be able to				

Unit V	USINESS DYNAMICS - ENGINEERING SERVICES INDUSTRY	9 Hours
Essenti	ndustry - Engineering Services Industry - Product Development in Industry versus Acader ials - Introduction to Vertical Specific Product Development Processes - Product Development Control Processes - Product Development	mia —The IPD nt Trade-offs -
Interiec	ctual Property Rights – Security and Configuration Management. Total:	45 Hours
Furthe	er Reading:	45 Hours
	1. Rapid Prototyping and Rapid Manufacturing	
	2. PESTLE Analysis	
Course	e Outcomes:	
	After completion of the course, Student will be able to	
	Define, formulate and analyze a problem	
	2. Solve specific problems independently or as part of a team	
	3. Gain knowledge of the Innovation & Product Development process in the Business of the Innovation and Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Business of the Innovation & Product Development process in the Innovation & Process in the Innovation & Product Development Process in the Innovation & Process in the Innovat	iness Context
	4 Work independently and also in teams	
	Manage a project from beginning to end	
Refere	ences:	
i.	Mark & Sanders and Ernest J McCormick, "Human Factors in Engineering and Design", McGi Education, Seventin Edition, 2013	raw Hill
2.	Hiriyappa 6, Corporate Strategy - Managing the Businessl, Author House, 2013.	
3.		raw Hill, Fifth
	Edition, 2011.	
4.	John W Newstown and Kenth Davis, 'Organizational Behavior', Tata McGraw Hill, Ele 2005.	venth Edition,
5.	A. Peter i Drupker People and Performancel, Butterworth - Heinemann [Elsevier], Oxford,	2004.
6.	Vined Kumur Gury and Venkita Krishnan N K	

Frofessional Electives - VI

1703EC021	ADV ANCED DIGITAL SIGNAL PROCESSING	L	T	P	C
		3	0	0	3
Course Objectives:	To provide in-deprit treatment on methods and techniques in		1		1
	Discrete-time stands transforms, digital filter design, optimal filtering	7			
2	Power spectrum es imation, multi-rate digital signal processing	£	-		
3.	DSP architectures which are of importance in the areas of signal process municages.	essing,	contro	ol and	
Unit! Parasa	etric Methods for Power Spectrum Estimation			9 F	lours
Estimation of spectra	anumetric Methods for Power Spectrum Estimation from finite duration observation of signals; Non-Parametric Method	ds: Bar	tlett -		lours h and
Blackman - Juley me Unit III Adapti	ve Signal Processing			9 F	Iours
FIR Adaptive Theis	: Stoopest descent adaptive filter - LMS algorithm - converge neellation channel equal zation; Adaptive recursive filters - recursive	ence of	LMS	algori	
	ate Signal Processing				lours
	to: Let the produce of a factor 1 - Viiter design and implement of the special and implement of the spe	ntation	forsa	npling	g rate
	e 7 ansforms			9 H	lours
	Discrete Fourier transform - discrete cosine transform; WaveletTrans function spaces- justed spaces —Haarwavelet function - orthogor				

normalization of Haar b	eases at differentscales - Daubechies wavelets -support of wavelet system.		45.7	
Further Reading:	Total:		45 1	lours
ruither Resume	http://www.ti.com/processors/dsp/overview.html			-
Course Outcomes:				5
	apietion of the course. Student will be able to			
	sign adaptive filters for a given application Employa bil	itu	7	
	ign multirate DSP systems.	200	one	11715
References	V JEW	Y.	X4-66	1000
 J.G. Proakis an 	d D.G. Manolakis Digital Signal Processing Principles, Algorithms and A	Applica	tions',	
Pearson Educat	tion New Dorb., 14th 2005.	3 5		
2. Monson H. Hay	yes, "Statistical Digital Signal Processing and Modeling", Wiley, 2002.			
3. Roberto Crist, '	"Mudern Digital Signal Processing". Thomson Brooks/ Cole, 2004.			
	Rau and Ajirs Benardikar, Waveler Transforms: Introduction to Theorya	nd Apr	licatio	ns".
_	tion: Asia, 2009	120	~	[3
	K. I Ramachamadran and N.G Reshmi, "Insights into Wavelets."	2/3	+	
6. Theorem Pro	The Francisco Resident Following Control Proc Salar	10111		
0. Theory 1,13 is	wice". 3-a Edition, Frantice Hall of India, 2010. Dr. S. RAMAB	CIPAL	I, M.E.,	Ph.D.,
	E.G.S. Pillay Eng			
	Thathi Non	Ara 61	4 000	
170200000	Namanatinam	(Dt) Tar	nil Nat	u. c
1703EC022		3 0		3
		3 0	0	3
Course Objectives:	CHORDEN - NA CARRA CARA LINEAR MARINE			
the second of th	In this course it is aimed to Understand the fundamentals of embedded sys	tems d	ifferen	res of
	mucroprocessor and controller.	nome a	11101011	000 01
	Understand the intercoontroller architecture and pin diagrams.			
	Uniterstand and able to write the assemble language program.			
4	i incommend and able to write the I/O and timers/counter programming			
5	To use the embedded controllers. In real time applications			
	ed system introduction			lours
	dded system, embedded system architecture, classifications of en			
	issues in embedded systems, fundamentals of embedded processor and			
	amentals of Vonneuman/Harvard architectures, types of microcontro	ollers,	selecti	on of
microcontroilers.	B (00 1 1 1 00 1 1 00 1 1 1 1 1 1 1 1 1 1	-1	Α.Υ	T
	ptrofer (89031 & 8988) & 89852)	0021		lours
	agram of each series -Complete Pin description-Difference between a struction sensused in ATMEL-Types of instructions -Timers/Counters			
	is counters. Simple programs.	5 WILLI	1/O p	UILS -
	ta itature	1	9 F	lours
	Microcontrollers, Architecture of AVR Atmega32x Microcontroller,	Pin dia		
Family Overview, Atmu	eg: 32 Family Members, AVR Assembly Language Programming.		· D- · · · · · ·	
	ice Haterfactoy		9 I	lours
Assembly Language بين	of Embodica Colloquementing- Interfacing Simple I/O Devices Like LE	D, Sev		
LCD, Switches -89c51	and AVR controller			
	od controllers Application			lours
	Segual Contillering Relay Interfacing, Opto isolator and Stepper Mot	or Inte	rfacing	3,
PWM Programming at	ed DC Motor Control and various control applications.			
	Total:		45I	lours
Further Reading:	Senal communications, i2c communications			
				>
Course Outcomes.				
After con	upledor, of the course, Student will be able to			

1. Understand the micro and macroeconomic environment for a favorable business environment

2. Apply laws of demand and supply in engineering economy and forecast the demand

3. Evaluate the various costs and breakeven point for organizational profitability

4. Analyze the pricing, payback on investments and e-commerce completions.

5. Asses the influence of macro level economics, taxation in businesses and financial accounting process

References:

1. A Ramachandra Aryssri and V V Ramana Murthy, Engineering Economics and Financial Accounting, Tara McGraw Hill Publishing Company Limited, New Delhi, 2006.

2. R Kosawan, C Elanchezhian and T Sunder Selwyn, Engineering Economics and Financial Accounting, Laxmi Publication Ltd. New Delhi, 2005.

3. V I. Samuel Paul and G S Gupta, Managerial Economics Concepts and Cases, Tata McGraw Hill Publishing Company Limited. New Delhi, 1981.

4. S N Maheswari, Financial and Management Accounting, SultanChand

5. V I. Samuel Paul and G S Gupta, Managerial Economics-Concepts andCases.

6. Barthwell R.R., Industrial Economics - An Introductory Text Book, New Age.

1703MG	7007 FOUNDATION SKILLS IN INTEGRATED PRODUCT DEVELOPMENT	L	Т	P	С
		3	0	0	3
Course (Objectives:				
2.	To understand the recent subsequent development of global trends and develop various types of products and services. To conceptualize, prototyps and develop product management plan for a new product and development methodology integrating the hardware, software, and development methodology integrating the hardware, software, and development methodology integrating the hardware.	act base	ed on	the typ	oe of
ł	nechanical systems To understand requirement engineering and know how to collect, analyze and arrive				
	product development and convert them in to design specification	at roqu	01110		
Unit I	FUNDAMENTALS OF FEODUCT DEVELOPMENT			9 H	ours
of Produ	ion to Product Development Methodologies and Management - Overview of Product ct Development - Overview of Product Development methodologies - Product nent Planning and Management.	ts and Life (Servic Cycle	ces - T - Pro	ypes
Unit II	REQUIREMENTS AND SYSTEMDESIGN			9 H	ours
Requiren Requiren	tent Engineering - Types of Requirements - Quality Function Deployment & tent Management - Introduction to System Modeling - System Optimization-System	Phase Specif	s - Nicatio	Aodeli n.	ng -
Unit III	DESIGN AND TESTING				ours
Design a	ion to Concept generation Techniques - Concept Screening & Evaluation - Detailend Verification - High Level /Low Level product Design - S/W Testing- Hardware ayout and Hardware Testing.				
Unit IV	SUSTENANCE ENGINEERING AND END-OF-LIFE (EOL) SUPPORT			9 H	ours
Sustanar	ce - Maintenance and Repair - Ennancements - Product EOL - Obsolescence Manag		- Con	figurat	ion

1. Explain 3051,52 and AVR Microcontroller Architecture.
2. Develop an Assembly Language Program.
3. Build an interface for I/O Devices using Embedded C and ALP
4. Make use of internal and external peripherals.
5. Develop an Interface for Sensors and Actuators.

References:
1. Programming PIC microcontrollers with PIC basic by chuck helebuyck
2. PIC microcontrollers-programming in basic by Milan verile.
3. Mohammad Ali Mazidi, Sor and Naimi, SepahrNaimi; The AVR Microcontroller and Embedded Systems using Assembly and C; IstEdition, earson Education India.
4. Dhanar jay Cadret Programming and Customizing the AVR Microcontroller; 1 st Edition, McGraw Hill.
5. The 3051 Microcontroller and Embedded Systems Using Assembly and C Second Edition Muhammad Ali

Mazidi Janoz Cilli pie Vlasidi e li 19 McKinlay

UNDERBOOK SYSTEMS LABORATORY List of Experim dessi StudyofARMevaluationarysten: Interfacing ALIC and DAC Interfacing Oam WW Interfacing real meetock and solution Internacing seybonramed Co. 6. Interfacing EPROManc interrupt Mailbox Interrupt a formance paracteristics of a R Manuf P GA FlashingorLEL 10. interfacingstepper motor anotemperaturesensor implement suzigosephageot with ARM Total: 45 Hours Additional Experiments: UCD display using Arduino processor 2. Interfacing of keyboard and seriel port using Arduino processor Course Outcomes A fier completion of the course. Student will be able to Winteprograms in A Riviforaspecific Application Interface A/Dane Div.convertorswith ARMsystem Writeprogrammes for interfacing keyboard, display, motorands ensor consulateamini project inembeddedsystem References: 1. Sedra and Smith, "Micro Electronia Circuits"; Sixth Edition, Oxford University Press, 2011 2. Robert i. Boylestad and Louis Masheresky. "Electronic Devices and Circuit Theory", Oth Edition, Pearson Education (HEL 2004) David A. Bell. "Llestronic Devices and Circuits", Fifth Edition, Oxford University Press 2008
 Millman J. and Taulo et all Physics Digital and Switching Wavel Dr.S. RAMABALAN M.E., Ph.D., PRINCIPAL Millman and Halkins, C., Integrated Electronics, TMM, 2007. E.G.S. Pillay Engineering College, Thethi, Nagore - 611 002.

Nagapattinam (Dt) Tam	il Nadu	i.		
PATTERN RECOGNITION AND MACHINE LEARNING	L	T	P	C
	3	0	0	3
(Common to B.E / B. Tech - CSE, IT & ECE)				
Provide knowledge of moders, methods and tools used to solve regres feature selection and density estimation problems	sion, c	lassifi	cation,	
	flearni	ng		
			ns.	
	PATTER A RECOGNITION AND MACHINE LEARNING Common to B.E./B. Tech – CSE, IT & ECE) Provide knowledge of moders, methods and tools used to solve regres feature selection and density estimation problems Provide knowledge of learning and adaptation in supervised modes of	PATERAL RECOGNITION AND MACHINE LEARNING L 3 (Common to B.E./ B.Tech - CSE, IT & ECE) Provide knowledge of moders, methods and tools used to solve regression, of femure selection and density estimation problems Provide knowledge of learning and adaptation in supervised modes of learning	Nagapattinam (Dt) Tamil Nadu. PATTER RECOGNITION AND MACHINE LEARNING L T 3 0 (Common to B.E./ B.Tech – CSE, IT & ECE) Provide knowledge of moders, methods and tools used to solve regression, classificature selection and density estimation problems Provide knowledge of learning and adaptation in supervised modes of learning	Nagapattinam (Dt) Tamil Nadu. PATTER RECOGNITION AND MACHINE LEARNING L T P 3 0 0 Common to B.E./B.Tech - CSE, IT & ECE) Provide knowledge of models, methods and tools used to solve regression, classification, feature selection and density estimation problems

	4. Provide knowledge of cultent research topics and issues in Pattern Recog	nition a	nd Ma	chine
	5. Provide knowledge about sinear functions	-		
Unit I	SPEECH FUNDAMENTALS		9	Hours
Articulatory	Phonetics - Production and Classification of Speech Sounds; Acoustic Phonetics -	- acoust	cs of	speech
Methods	Review of Digital Signal Processing concepts; Short-Time Fourier Transform, F	ilter-Ba	nk and	d LPC
Unit II	VLSI SIGNAU PROCESSING			Hours
An overvial Techniques	of DSP concepts. Representations of DSP algorithms Loop bound and iteration bo Retiming. Edicing and Unfolding	ound-Tr	nsfor	mation
Unit III	RESYSTEM DESIGN		9	Hours
Characterism low noise cir	es-amplifier over minima - stability considerations- constant gain circles- concles procedured high power and multistage amplifiers.	stant VS	SWR c	circles-
Unit IV	MULTIMEDIA COMMUNICATION			Hours
Introduction animation v	- Multimedia skills - Multimedia components and their characteristics - Text, sour idea, hardware	nd, imag	es, gra	aphics,
	CLOUD COMPUTING S for Network - Breatmann - System Models for Distributed and Cloud Comp		12	Hours
demand.	olic vs Provide Cicud -Ched Bolunous - Cloud ecosystem - Service manageme			ing on
	Total:			Hours
Further Rea	iding*	45	+ 15	Hours
		45	+ 15	Hours
	Iding: Dimensional Requesion and Model Selection, On Feature Selection in Gaussian M	45	+ 15	Hours
Further Rea	Iding: Dimensional Requesion and Model Selection, On Feature Selection in Gaussian Means: English Lancoured and Meansers, Justient will be able to	45	+ 15 Cluster	Hours
Further Rea	Omensional Reduction and Model Selection, On Feature Selection in Gaussian M Constant Complete of the constant will be able to Employee Advanced Patrent Recognition and Machine Learning can offer a	45 lixture (+ 15 Cluster	Hours
Further Rea	Iding: Dimensional Requesion and Model Selection, On Feature Selection in Gaussian Means: English Lancoured and Meansers, Justient will be able to	45 lixture (+ 15 Cluster	Hours
Further Rea	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Selection Model Selection in Gaussian Model Selection Model Selection Model Selection in Gaussian Model Selection in G	45 lixture (+ 15 Cluster	Hours
Further Rea	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Select	45 lixture (+ 15 Cluster	Hours
Further Res	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Selection Model Selection in Gaussian Model Selection Model Selection Model Selection in Gaussian Model Selection in G	45 lixture (+ 15 Cluster	Hours
Further Res	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Selection and Machine Learning can offer a 2: Describe the greensth and limitations of some techniques used in computation to the green selection and density estimation problems. Describe some discriminative, generative and kernel based techniques 3: Describe and model sequential data.	45 lixture (solutional Ma	Cluster	Hours
Course Out	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Selection and Machine Learning can offer a 2th Describe the amount of the interest of some techniques used in computation of the interest of the int	ducation ey, inter	cluster	Hours ing
References: 1.Lawrence 2. Keshab k. 3.Reinhold I	Dimensional Reduction and Model Selection, On Feature Selection in Gaussian Model Selection and Machine Learning can offer a 2th Describe the amount of Selection and Machine Learning can offer a 2th Describe some discriminative, generative and density estimation problems. The scribe some discriminative, generative and kernel based techniques of Describe and the del sequential data. The scribe and Include the scription of Speech Recognition, Pearson E 20 E.S. Pillay Engineering College.	ducation ey, inter	cluster	Hours ing
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1703EC024	SPEECH PROCESSING	L	T	P	C
		3	0	0	3
Course Obje	petives:	1	L		
	is. To make the students to understand the digital Speech fundamentals,				
	2. To study the digital models and processing of speech signal				
	3. To acquite the basic knowledge in filters, voice enhancement, voice res	toratio	n and		
Unit I	SPEECH PRODUCTION MGDEL			9 н	ours
1D sound w	raves-functions) block of the Vocal tract model—Linear predictive co- effici- nethod-Levinson-durbin algorithm-Auto-co- variance method-Lattice structure			-Aut	to-

Lattice co-efficient from IPC-Phonotic Representation of speech-Perception of Loudness - Critical bands -
Pitch perception - Audslery masking.
Unit IT SEATURE EXTRACTION OF THE SPEECH SIGNAL 9 Hours
Endpoint detection-Dynamic time warping. Eltch frequency estimation: Autocorrelation approach- Homomorphic
approach-Formant frequency estimation using vocal tract model and Homomorphic approach-Linear predictive co-
efficient -Poles of the vocal tract-Reffection co-efficient-Log Arearatio
Unit III FREQUENCY DOMAIN METHODS FOR SPEECH PROCESSING 9 Hours
Cepstrum- Line spectral frequencies- Functional blocks of the ear- Mel frequency cepstral co-efficients-
Spectrogram-Thus resolution versus il equancy e solution-Discrete wavelettransformation.
Unit IV PATTERN RUCOG ATTION FOR SPEECH DETECTION 9 Hours
Back-propagation Neural Neural Neural Vootor Machine-Hidden Markov Model (HMM)-Gaussian Mixture
Model(GMM) -Unsuber Led Learning system. K-Means and Fuzzy K-means clustering - Kohonen self-
organizing man-Duntus anality adaction techniques: Principle component analysis (PCA), Linear
discriminant analysis (LDA), Kernel LDA (KLDA), Independent component analysis(ICA). Unit V SPEECH ANALYSIS AND SYNTHYSIS 9 Hours
Z TIOUIS
Non-uniform quantization for Guessian distributed data- Adaptive quantization-Differential pulse code modulation-
Code Exhad Linear production of ELF aduation assessment of the compressed speech signal Text to Speech (TTS)
analysis -Evolution of queen a speakeris's mems-limit selection methods - TTS Applications
Further Reading: 45 Hours
Phonetic Mechanisms in Speach Feix epison
Disorders of serraheral and Central Auditory Processing
Neurobiology of Statistical talormation Processing in the Auditory Domain
Course Outcomes
After completion of the course, Student will be able to
Illustrate how the speech production is modeled
2. Summarize the various techniques involved in collecting the features from the speech signal
in both time and frequency domain
summarize the runctional blocks of the ear.
4 cumpare the various nattern recognition techniques involved in speech and speaker
detection
References:
1. L.R.Rabiner and R.W.Schafer. Introduction to Digital speech processing", now publishers USA, 2007
2. E.S.Gooi, "Digital speech processing testing testing testing restrict." Springer, 2014
3. L.R.Rabiner and "W.S.Shofer," The Processing of speech signals", PrenticeHall, 1978
4. T.F. Quatieri, "Discrete-line Speech Equal Processing", Prentice-Hall, PTR, 2001
5. L. Hanzaetel, "Voice Compression and Communications", Wiley/ IEEE ,2001.

1703EC025	3 % Ci Cianal Bassasian	L	T	P	C
	VESI Signal Processing	3	0	0	3
Course Ob	ectives:				
	1. To enable students to Jesign VLSI systems with high speed and low	power.			
	To encourage students to develop a working knowledge of the centra DSP algorithm with optimized hardware.	al ideas of in	nplem	entatio	on of
Unit I	INTRODUCTION TO DEP SYSTEMS			9 H	lours
	of DSP concerts, Representations of DSP algorithms, Systolic Architectur x-Matrix Multiplication, 2D Systolic Array Design, Digital Lattice Filter St				m,

Derivation of One-Application Lauther Education of Lattice Filter. Pipelining of Lattice Filter.	
Unit II PPELINING AND RETIMING	9 Hours
Scaling and Lound off Noise state description of digital filters, Scaling and Round off No	ise
computation. Round off Noise in Pipeliped IIR Filters, Round off Noise Computation using st	ate variable
description, Slow-down, Retirring and Pinalining.	
Unit III BIT-LEVEL ARITHMETIC ARCHITECTURES	9 Hours
Bit level arithmene architectures, parallel multipliers, interleaved floor-plan and bit-plane- based dig	gital filters, Bit
serial multipliers. Bit serial filter design and maph mentation. Canonic signed digit arithmetic, Distrib	
Unit IV REDENANT ARTECHMETIC	9 Hours
Redundant administration Redundent near the representations carry free radix-2 addition and subtraction	, Hybrid radix-4
addition, Radix-2 hybrid and and an invitibility tion architectures, data format conversion, Redundant t	o Non
redundant converter	
Unit V NUMERICAL STREAUTH REDUCTION	9 Hours
Numerical Strength Reduction Subscripts on Elimination, Multiple Constant Multiplication, Subscripts	kpression
Sharing in Digital Filter, And live . Multiplies are Number Splitting.	
Total.	45.16
Further Rending	45 Hours
1. Special decoders	
the contract of the contract o	
Course Outcomes: Enterpreneurship	
	hole
After completion of the entires. Student will be able to Lingary and basics of DSP systems.	11194
2 Know about algorithmic strength reduction	
The wood ordinate straight founding	
Carried to the street	
Convolute IIP, filters	
Rightilly bit level withmetic algorithms	
1. Identity bit level arithmetic algorithms 2. Compare protocols	
1 Ideratly bit level arithmetic algorithms 3. Compare processis References:	W/Nov
References: 1. Kechan K. Parla in VLSI English Signal Processing Systems, Design and implementation ", V	Wiley,
1 Identity bit level arithmetic algorithms 2. Compare processis References:	Wiley,
References: 1. Kechap K. Parlin * VLSI Eight Signal Processing Systems, Design and implementation ", Vlinterscience, 1999.	
References: i. Kecha. C. Partin - VLSI Eighal's goal Processing Systems, Design and implementation ", Value of England and Design and Design and Implementation and Design and	
References: i. Kecha. C. Partin - VLSI Eighal's goal Processing Systems, Design and implementation ", Value of England and Design and Design and Implementation and Design and	
References: 1. Kecha, K. Parha - VESI English Signal Processing Systems, Design and implementation ", Vinterscience, large 2. U. Meyer - Bausa - Discount State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of the Stat	
References: 1. Kecha, K. Parha - VESI English Signal Processing Systems, Design and implementation ", Vinterscience, large 2. U. Meyer - Bausa - Discount State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of Processing Systems, Design and implementation ", Vinterscience, large of the State of the Stat	
References: i. Keenas M. Perha : VESI English is good Processing Systems, Design and implementation ", Value of the Bases of Dr. S. RAMABALAN, M.E., Ph.D. PRINCIPAL E.G.S. Pillay Engineering College, Thethi, Nacons, 2019	
References: 1. Kechao K. Park and VLSI English's goal Processing Systems, Design and implementation ", Value of the Basic Lines. 2. U. Meyer - Basic Design and Design and Processing Systems, Design and implementation ", Value of the Basic Lines. Dr. S. RAMABALAN, M.E., Ph.D.	

1703EC026	3EC026 L					
	RF SYSTEM DESIGN	3	0	0	3	
Course Obj	ectives:					
	1. To understand the basics of system design					
	To understand the concepts of radio architectures					
	3. To introduce to the students the transmitter and receiver system designantlysis.	n techn	iques	and		
	4 To learn the applications of RE systems in wireless communication.					
Unit I	. TRANSCLIVER ARCHITECTURES			9 H	ours	
			nonen	ts for	RF	
Heterodyne Impedance	and Homodyne erchitectures, Discrete and CMOS realization passiv Metching Distortion HP5 and Blocking Effects, Noise Figure, Noise ma central blocks.	e com	condi	tions.	Friis	

loss, Active mixers. Gilbert cells. linearity and Noise Figure of mixers	
Unit III OSCILLATORS	9 Hours
Negative transconductance, nonlinearit, and Differential LC tuned oscillators, Ring oscillator, Quadrature oscillators—Phase noise	
Unit IV PLLS AND SYNTHESEZERS	9 Hours
Phase Detectors, charge pumps and their transfer functions, Synthesizers based on first, seco PLLs and stability issues, introduction to integer and fractional N synthesizers	nd and third order
Unit V POWER AMPLIFIERS	9 Hours
Class A, B, C, D, E, F and AB power amplifiers, Linearization and impedance matching amplifiers.	g issues of power
Total:	45 Hours
Further Reading: Measurement of noise, Jitter, SFOR, intermodulation products for RF system	
Course Outcomes	
rier completion of the course. Student will be able to	¥-
1. Understand radio transceiver architectures	
2. Design and Analyze CMOS LNAs, Mixers	
3. Dosign and Analyze Oscillators, PLLs,	
Design and Analyze Synthesizers and Power Amplifiers.	
References:	
1. B. Razavi, — RF Microero-Tronics!, Pearson Education, 2nd edition, 2012.	
 Thomas Lee, — The Design of CMOS Radio Frequency Integrated Circuits, Cam Press, Second Edition, 2004 	bridge University
 Zhipe: Chi. Wesh Performance High Speed VLSI Architectures for Wireless Applications University of Minnesota, 2000. 	Communication

E.G.S.PH.LAYENGINEERINGCOLLEGE

(Autonomous)

Approved by AICTE, New Delhi Affiliated to AnnaUniversity, Chennai Accredited by NAAC with "A"Gradej Accredited by NBA (CSE, EEE, MECH)

NAGAPATTINAM—611002



B.E. Diectronics and Communication Engineering

Full Time Curriculum and Syllabus

Fourth Year-Eighth Semester

Course	Course Name		т	T	m		Max	imum	Marks
Code	COURSELANDER		L	T	P	C	CA	ES	Total
Theory Cou	rse					-			
	Professional Elective -VIII		3	-	-	3	40	60	100
	Professional Elective -VIII		3	-	э	3	40	60	100
	Profescional Elective - IX		3			3	40	60	100
Laboratory	Course					-			
1704EC851	Project Work		-	-	18	9	50	50	100
	T	stal	9	35	18	18	170	230	400
Professional El	lective - VII	-							
1703EC027	Multimedia Communication		3	0	0	3	40	60	100
1703EC028	Wireless Sensor Networks		3	0	0	3	40	60	100
1703EC029	Rada, and Nuvigation Aids		3	0	0	3	40	60	100
1703EC030	Microwave Integrated Circuits		3	0	0	3	40	60	100
1703EC03 i	Satellile Communication		3	0	0	3	40	60	100
Professional El	lective - VIII								
1703EC032	System-on Chip Design		3	0	0	3	40	60	100
1703EC033	Network on Chip Desicn		3	0	0	3	40	60	100
1703EC034	Low Power VLSI Design		3	0	0	3	40	60	100
1703EC035	Analog IC Design		3	0	0	3	40	60	100
1703EC036	iMixed Signal CMOS Design		3	0	0	3	40	60	100

Professional El	ective - EX							78
1703EC037	Electromagnetic Interference and Compatibility	3	0	0	3	40	60	100
1703EC038	Digita! System Design and Testing	3	0	0	3	40	60	100
1703EC039	Optical Networks	3	0	0	3	40	60	100
1703EC040	RF MEMS	3	0	0	3	40	60	100
1703EC041	Digital Switching and Transmission	3	0	0	3	40	60	100
1703EC042	ARM Processors	3	0	0	3	40	60	100
1703EC043	Mooile Computing	3	0	0	3	40	60	100

Professional Elective - VII

	WELL TIMEDIA COMMUNICATIONS	L	T	P	С
		3	0	0	3
	(Common to B.E / B.Tech –ECE, CSE, IT)				
Course Objective					
	.To have a detailed knowledge of compression and decompression technique	es			
	To introduce the concepts of multimedia communication				
	. To introduce standards of MPEG				
Unit I	ntroduction to Mullimedia Communications			5 1	Hours
Components of	multimedia system. Desirable features, Applications of multimedia system	ns, I	ntrod	uction	to
different types. A	Iultimedia storage device.				
	ligital audio representation				lours
Digital audio re	presentation and processing-time domain and transform domain repre	senta	tions.	Codi	ng
standards mans r	ission and processing of digital audio. Musical instrument synthesizers.				
	mage coding algorithms				Hours
Still image coc	ing-IPEG. Discrete cosine Transform. Sequential and Progressive DO	CT b	ased	encodi	ng
algorithms, loss	ess coding, intercretical coding. Basic concepts of discrete wavelet trans	ısforr	n co	ding a	nd
	coding algorithms, introduction to JPEG2000.				
	1PEG				Hours
MPEG video enc	1, streature of encoding and decoding process, MPEG 2 enhancements, and oder.	diffe	erent	blocks	of
Unit V	Tibeo and ng	T		10 1	Tours
	Affected righted and MPEG 4 video, motion estimation and compensate	tion.	Diffe		
Content based v	Theo and mg. dec adding-overview of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. oding techniques.	tion. An o	Diffe	erent c	oding
Content based vitechniques and video	des ceding-overview of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. oding techniques. Total:	tion.	Diffe	erent c	Hours oding H261
Content based vitechniques and video and H263 video Further Readion	des ceding-overvier of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. oding techniques. Total:	tion.	Diffe	erent c	oding H261
Content based vitechniques and video Further Reading	discocding-overview of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. oding techniques. Total: Advanced compression rechniques	tion. An c	Diffe	erent c	oding H261
Content based vitechniques and video Further Reading	des ceding-overvier of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. oding techniques. Total: Advanced compression rechniques Coding Techniques	tion.	Diffe	erent c	oding H261
Content based vitechniques and video and H263 video Further Reading Course Outcom	des coding-overvier of MPEG 4 video, motion estimation and compensate rification models. Block diagram of MPEG 4 video encoder and decoder. ording techniques Total: Advanced compression rechniques Coding Techniques	tion. An o	Diffe	erent c	oding H261
Content based vitechniques and video and H263 video Further Reading Course Outcom	des coding-overvier of MPEG 4 video, motion estimation and compensate diffication models. Block diagram of MPEG 4 video encoder and decoder, ording techniques. Total: Advanced compression rechniques Coding Techniques as:	tion.	Diffe	erent c	oding H261
Content based vitechniques and video and H263 video Further Reading Course Outcom	dec. colleg-overela. If MPEG 4 video, motion estimation and compensate diffication models. Block diagram of MPEG 4 video encoder and decoder. ording techniques. Total: Advanced compression rechniques Coding Techniques estimation of the course, Student will be able to L. Describe various multimedia components	tion.	Diffe	erent c	oding H261
Content based vitechniques and video and H263 video Further Reading Course Outcom	dec. colleg-overvice of MPEG 4 video, motion estimation and compensate erification models. Block diagram of MPEG 4 video encoder and decoder, ording to finiques. Total: Advanced compression rechniques Coding Techniques If the completion of the course, Student will be able to Describe various multimedia components Describe compression and decompression techniques	tion.	Diffe	erent c	oding H261
Content based vitechniques and video and H263 video Further Reading Course Outcom	des colleg-overvier of MPEG 4 video, motion estimation and compensate diffication models. Block diagram of MPEG 4 video encoder and decoder, ording techniques. Total: Advanced compression rechniques Coding Techniques se: After completion of the course, Student will be able to L. Describe various multimedia components Describe compression and decompression techniques Apply the compression concepts in multimedia communication	tion. An o	Diffe	erent c	oding H261
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Content based v techniques and v and H263 video Further Reading Course Outcom	des colleg-overvier of MPEG 4 video, motion estimation and compensate diffication models. Block diagram of MPEG 4 video encoder and decoder, ording techniques. Total: Advanced compression rechniques Coding Techniques se: After completion of the course, Student will be able to L. Describe various multimedia components Describe compression and decompression techniques Apply the compression concepts in multimedia communication	tion. An o	Diffe	erent c	oding H261
Content based v techniques and v and H263 video Further Readist Course Outcom References:	des colleg-overvier of MPEG 4 video, motion estimation and compensate diffication models. Block diagram of MPEG 4 video encoder and decoder, orling techniques. Total: Advanced compression rechniques Coding Techniques Session of the course, Student will be able to Describe various multimedia components Describe compression and decompression techniques Apply the compression concepts in multimedia communication Describe the video encoding	tion. An o	Diffe	erent c	oding H261

- 2. J.S. Chitode, "Information coding techniques", Technical publications, 1st edition 2007.
- 3. Raif steinmetz, Klara Nahrstedt, "Multimedia: Computing, Communications and Applications", Pearson education, 2002
- 4. John Billamil, Louis Molina, "Multimedia: An Introduction", PHI, 2002

	WIRELESS SENSOR NETWORKS	L	T	P	С
		3	0	0	3
	(Common to B.E / B.Tech – CSE, IT & ECE)				
Course Object					ž.
	1. To study about Wireless networks, protocol stack and standards.				
	2. To study about fundamentals of 3G Services, its protocols and app				
	3. To study about evolution of 4G Networks, its architecture and app	lications.			
Unit I	MIRTH PSC SPECIMORIC POSTATEOTARD				
	WIRELESS NETWORK ARCHITECTURE Wireless network logical architecture – Network physical architecture	****			our
System archite BRAN, Hiper MAC, Spectru	ecture, protocor architecture, physical layer, MAC layer, 802.11 Enhanc LAN2 – Bluetooth- VoWLAN and VoIP security – WPA- IEEE80 im allocation for WIMAX ADHOC AND SENSOR NETWORKS	ements - Hipe	r LA	I: WA	ATM ayei
	Mobile IP: IP packet delivery, Agent discovery, tunneling and encap	1 101/2		. 9 H	our
enhancements recovery, Influ	for wireless protocols - Traditional TCP: Windows based Congesticeness of mobility on TCP medianism - Classical TCP improvements: Time out freezing, Selective retransmission, Transaction oriented T	on control, fas Indirect TCP,	t retra	ansmi ping	t/fas TCP
networks	The state of the s	101 101 0	0. 5.	,,,,,,	0,00
Unit IV	DESIGN OF WIRELESS WIDE AREA NETWORK			9 H	our
CCON SMC	L-UMTE Core research Architecture: link budgets for GSM, CDM	A, 3G-MSC, 3	G- S	GSN,	3G
GGSN, SMS-6 LTE network a Unit V Introduction — network routin	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parachitecture and pretocol. CURRENT AND FLITURE OF WIRELESS NETWORKING TEC 4G vision – 4G features and challenges - Applications of 4G – Leading-Network independent roaming- Gigabit wireless LANs- OFD	cket access (HSCHNOLOGY	SDPA : Wire)syste 9 H eless	ems l our mesl
GGSN, SMS (LTE network a Unit V Introduction – network routi	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parachitecture and pretocol. CURRENT AND FLTURE OF WIRELESS NETWORKING TECT 4G vision – 4G features and challenges - Applications of 4G – Leadi	cket access (HSCHNOLOGY	SDPA : Wire)syste 9 H eless	ours mest ptive
GGSN, SMS (LTE network a Unit V Introduction — network roution Modulation an	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parachitecture and pretocol. CURRENT AND FLITURE OF WIRELESS NETWORKING TEC 4G vision – 4G features and challenges - Applications of 4G – Leading-Network independent roaming-Gigabit wireless LANs-OFD id coding with size flot scheduler Cognitive Radio	cket access (HSCHNOLOGY) ing edge WNT M-MIMO sys	SDPA : Wire	9 H eless Ada	our mesl ptive
GGSN, SMS-(LTE network a Unit V Introduction – network routin Modulation an Further Read	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parablecture and pretocol. CURRENT AND FLITURE OF WIRELESS NETWORKING TEC 4G vision - 4G features and challenges - Applications of 4G - Leading-Network independent roaming-Gigabit wireless LANs-OFD ad coding with time Got scheduler Cognitive Radio ing. Signal Encoding Techniques, Cordless Systems and Wireless Local Lo	CHNOLOGY Ing edge WNT IM-MIMO sys Total:	SDPA : Wire	9 H eless Ada	ours mest ptive
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GGSN, SMS-C LTE network a Unit V Introduction — network roution Modulation an Further Read	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parachitecture and pretocol. CURRENT AND FLTURE OF WIRELESS NETWORKING TEC. 4G vision – 4G features and challenges - Applications of 4G – Leading-Network independent roaming-Gigabit wireless LANs-OFD ad coding with sime clot scheduler Cognitive Radio ing. Signal Encoding rechniques, Cordiess Systems and Wireless Local Lo Equalization, Coding, and Diversity, Heterogeneous Wireless Network offices: After completion of the course, Student will be able to 1. Conversant with the latest 3G/4G and WiMAX networks and its and Design and implement Routing Techniques	cket access (HSCHNOLOGY) ing edge WNT M-MIMO sys Total: op s Prendu rehitecture.	Wire Wire	9 Heless Ada	our
GGSN, SMS (LTE network a Unit V Introduction — network routin Modulation an Further Read	GMSC/SMS-fWMSC, Firewall, DNS/DHCP-High speed Downlink parachitecture and pretocol. CURRENT AND FLTURE OF WIRELESS NETWORKING TEC. 4G vision – 4G features and challenges - Applications of 4G – Leading-Network independent roaming-Gigabit wireless LANs-OFD id coding virinitize flot scheduler Cognitive Radio ing. Signal Encoding Techniques, Cordiess Systems and Wireless Local Lo Equalization, Coding, and Diversity, Heterogeneous Wireless Network ones: After completion of the course, Student will be able to 1. Conversant with the latest 3G/4G and WIMAX networks and its at 2. Design and implement Routing Techniques 2. Analyze wireless network environment for any application using	cket access (HSCHNOLOGY) ing edge WNT M-MIMO sys Total: op s Prendu rehitecture.	Wire Wire	9 Heless Ada	our
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E.G.S. Pillay Engineering College, Thethi, Nagore - 611 002. Nagapattinam (Dt) Tamil Nadu.

1703EC029	RADAR AND NAVIGATION AIDS	L	Т	P	С
201		3	0	0	3
Course Objectiv					
1,	Able to understand radar equations and types of radar				
2.	Able to understand aids and navigation systems				
3.	Obtain the knowledge of Doppler effects and equations nd detect the movin	ig ob	jects		
WI LOW TO STATE			-		
	DAR EQUATIONS		1		ours
RADAR Block I	Diagram & operation- RADAR Frequencies- RADAR Equation- Detection	of s	ignal	s in N	oise-
	etion of targets- RADAR cross section fluctuations- transmitter power- pulse	repe	tition	freque	ency-
	propagation effects	-	T -		
	HAND PULSE DOPPLER RADAR		1	9 H	ours
Non Coherent M	oppler & MTI RADAR- Delay Line canceller- Moving Target Detector- Pul	se D	opple	r RAL	AR-
Sequential Lobins	TE-CW RADAR- FMCW RADAR- Tracking RADAR- Monopulse Tracking	g – (Conic	al Scai	and
	B. DAS SIGNAL DETECTION AND PROPAGATION ON WAVES		1	Δ.11	
		1.1.	<u> </u>		ours
	sutomatic detection- constant false alarm rate receiver- information availa				
propagation propagation	m- pulse compression- introduction to clutter- surface clutter RADAR of	equa	-HOII	anom	aious
	ACKING, MAGING AND SCENNING RADAR		1	0 II	ours
	an monop use tracking ,comeal scan and sequential lobing, low angle track	kina	oir o		
radar. Introduction	to synthetic aperture radar threeking in range and Doppler, acquisition Prin	cinle	an :	hased	arrav
	nning, and its operation. Radio ranges: LF/MF four course radio ranges, V				
range vor receivi	ne equipment. Hyperbolic system of nevigation :LORAN, DECCA		Ommi	ancot	ionai
	TELLITE NAVIGATIONAL SYSTEM			9 H	ours
	g system. Ground controlled approach system, Microwave landing system,	Dis	tance		
equipment ,TAC	AM Doppler pavigation Doppler effect, Track stabilization .SATELLI	ΓΕ ι	navig	ation	GPS
principle of opera	sions, per lieu lecetion determination, principle of GPS receiver and applicatio	ns	Ü		
	Total:			45 H	aurs
Further Reading				10 11	July
	S principle of operation, Position location determination, principle of	GE	S re	ceiver	and
	denous	0.	5 10	001701	ana
'. \					
Course Outcome	Fraplouabili	TI	1		
	er completion of the course. Student will be able to	1			
	Students equipped to find the range and tracking moving object	0			
2.1	Learn the equations of radar and Doppier effect				
94	Study the satellite navigation system				
A.	Learn the range equation				
35.	Understand Principles of navigation and landing aids	/	1		
References:	170	-/			
1. "Incroduc	tion to radar system", Merriji I.skolnik 3 rd edition Tata McGraw 2003				
2. "Elemena	s electronic navigation system", N.S. Nagaraja, 2nd edition Tata MeGrava Num	200	n.D.		
3. "Princip	e of Kadar J.C. formay PHI 2 rd edition 2004. Dr. S. RAMIABATEAN				
4. "Radar F	ringinies Person / Veebles John Wiley 2004	olle	ge,		
er i Strinore	E.G.S. Pillay Engineering S Thethi, Nagore - 611 9	02.			
	Thethi, Nagore - 611 o Nagapattinam (Dt) Tamil	Nad	u.		
	Nagapattinam				

1703EC030	MICROWAVE INTEGRATED CIRCUITS	L	T	P	C				
		3	0	0	3				
Course Object	ives:		-						
	1. To inhance the students knowledge in the area of planar microwave engineering and to make them understand the intricacies in the design of microwave circuits.								
	2. To impart knowledge about the state of art in MIC technology.								

Nagapattinam (Dt) Tamil Nadu.

1703EC031	SATELLET'E COMMUNICATION	L	T	P	C
		3	0	0	3
Course Objectis	AC.				
	Le To impart knowledge about the Satellite communication.				
	2. To enhance the students' knowledge in astronomy and space				
Unit I SA	TELLITE ORBITS			9 H	ours

Introduction - Spectrum allocations for satellite systems -Kepler's Laws - orbital parameters - orbital perturbations - station keeping - Type of orbits - Geo stationary orbits - look angle determination- limits of visibility - eclipse sub-sitellite point - sun transit outage - launching procedures - launch vehicles and propulsion. Unit II SPACE AND EARTH SEGMENT Spacecraft technology- structure- power supply- attitude and orbit control - thermal control and propulsion communication subsystems - telementy, tracking and command - TranspondersAntenna subsystem, Equipment reliability. Earth station technology -Receive only home TV systems - MATV - CATV - Transmit Receive Earth Stations. Unit III I SATELLITE ACCESS 9 Hours Modulation and Multiples in a Voice, Data, Video, Analog - digital transmission system-Digital video broadcast - multiple access: FDMA, TDMA, CDMA- assignment methods -spread spectrum communication -compression encryption. Mobile satellite Service GSVI, CPS, communication between satellites SATELLITEEINK DESIGN Introduction- Equivalent isotropic addited power -Transmission Losses - Link power budget equation -System Noise, Carrier to Noise ratio - uplink - downlink - effects of rain - combined uplink and downlink C/N ratio -inter modulation noise - Interference between satellite circuits. SHITTING TYPENCATIONS 12 Hours Satellite mobile agrains — 19 AT Budoset GPS - O homm-iridium Direct Broadcast satellites (DBS) - Direct to home Broad ast (DTH) -(Misital audio broadcast (DAB) - World space services, Business TV (BTV) -GRAMSAT - Specialized survives: E roull, Wideo conferencing, Internet- INTELSAT Series- INSAT -INMARSAT. Remote sea and 45 Hours Total: Further Reading. Linearthend in saterity communication, Recent launching satellites and its application, Commenication between satellites, Comparison of satellite Course Outcomes: After compection of the pourse, Student will be able to Our use orbital medianics and launch methodologies. Describe various space subsystems. 5. Excusin different subsystems of earth segment Design and analyze link power budget for satellites Describe in training Satellite Applications Referenceat 1. Wilbut L. Frackert, Hender G. Nayderhoud, Robert A. Nelson, "Satellite Communication Systems Engineering , Planace Hall Scarcon, 2007 2. N.Agarwai, "Design of Geodynchronous Space Craft", Prentice Hall, 1986. Bruce R. Elbert, "The Satellite Communication Applications", Hand Book, Artech House Bostan London, 1:197. Tri T. Ha. "Digital Satellite Communication" 11 nd edition, 1990. Emanuel Fitheriakis, "Manual of Satellite Communications", Mc Graw Hill Book Co., 1984. "Telseammunication Trans Mission Systems", Mc Graw-Hill Book Co., 1983 Brian Ackrego, "World Stablife Communication and earth station Design", BSP professional Books, 1990. G.B. Bleszard, "Introducing Smallile communications", NCC Publication, 1985.

Professional Electives - VIII

1703EC032	SYSTEM ON CHIP DESIGN	L	T	P	C
		3	0	0	3
Course Objectives:			L		L

M.Richieria, "Satellite Communication Systems-Design Principles", Macmillan 2003.

To introduce architecture and design concepts underlying system on chips To gain knowledge of designing SoCs To impart knowledge about the hardware-software design of a modest complexity chip the way from specifications, modeling, synthesis and physical design Unit I : SYSTEW ARCHITECTURE: OVERVIEW 9 Hours Components of the system --Processor architectures --Memory and addressing --system level interconnection -SeC design requirements and specifications -design integration -design complexity cycle time, die area and cost, ideal and oractical scaling, area-time-power tradeoff in processor design, Configurabile Unit II PROCESSOR SELECTION FOR SOC 9 Hours Overview occasion core selection. Basic concepts—instruction set, branches, interrupts and exceptions. Paric elements in instruction handling -Minimizing pipeline delays -reducing the cost of branches -Robust processors - Vector processors, VLIW processors, Superscalar processors. Unit III 9 Hours SoC external memory, SoC internal memory, Scratch pads and cache memory -cache organization and write policies -strategies for line replacement at mise time -split I-and D-caches -multilevel caches -SoC memory systems -board based memory systems -simple processor/memory interaction Unitiv INTERCONNECT ARCHITECTURES AND SOC CUSTOMIZATION 9 Hours Bus architectures -SoC standard buses -AMBA, CoreConnect -Processor customization approaches Reconfigurable teconologies -mastring designs onto reconfigurable devices -FPGA based design -Architecture of FPGA, FPGA interconnect technology, FPGA memory, Floor plan and routing. Unit v FFGA BASED EMBEDDED PROCESSOR 9 Hours Hardware Johnware task paragosing - FPGA fabric Immersed Processors -Soft Processors and Hard Processors - 7 col flow for Hardware Coldesign-Interfacing Processor with memory and peripherals - I vees of Concentration and trees - Wishbone interface. Avaion Switch Matrix, OPB Bus Interface, Creating a Customized Antonicommisser -FPGA-based Signal interfacing and Conditioning 45 Hours Total: Further Readings lidedest avstem design trends ..MPSot. a nestgo Course Outcomes: After completion of the course. Student will be able to Explain an important compenents of a System-on-Chip and an embedded system, Ve. cichal browne are embadded sortware 2.Outline the anglor design flows for digital hardware and embedded software LISCUSS for major produced and trade-offs concerning performance, cost and power Lamber of the strain of the strain of the systems Agein the knowledge of designing SoCs. at adarstand designing adaptement in specification, Modelling, synthesis and physical References: 1. Michael J. Frynn and Wayne Luk, Computer System Design: System-on-Chip", John Wiley and sons, 1011 2. Rabul Dobey. Introduction to Embudded System Design Using Field Programmable Gate Arrays', Springer Verlay Condon Ltd., 2009. 3. Sudeen Passiona and wind Dud, On-Chip Communication Architectures-System on Chip Interconnect, Essever, 2011 4. Wayne Wolf, "Modern WLSI Design - System - on - Chip Design", Prentice Hall, 3rd Edition, Wayne Wolf Modern VLST Design - 1P pase tice Hall, 4th Edition, 2008. Dr. S. RAMABAKAN, M.E., Ph.D.,

Dr. S. RAMABAEAN, M.E., M.E., PRINCIPAL

E.G.S. Pillay Engineering College,
Thethi, Nagore - 611 002.
Nagapattinam (Dt) Tamil Nadu.

1703EC033		NETWORK ON C	HIP	L	T	P	C
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Course Obj	the state of the second st						
		rious classes of Intercon					
		at routing recliniques fo					
	j. 5.knov. Lite hyporta	ace of flow control in or	-chip network				
Unit i	ICN ARCHIEC	a vive : O K				9 H	anr
		ks - Topologies - Direct	networks - Indirect net	works_Perform	ance		
Unit ii	SANCTA ISSAU ARK		nerworks - muneet net	WOLKS-1 C110111	IdileC (9 H	
Basic switch		ai channels - Hybrid sw	itching techniques Opt	mizing switch	ing te		
		er Deadlock, fivelock a			0	1	
Unit 111	ROUTING TEUR				- T	9 H	our
Taxonom (- Derenmirastic couting	g algorithms - Partially	adaptive alg	orithn	ns - F	ull
		IINs - Routing in switch					
allocation po	dicies. First control.						
Unit (1)	NETWORK OF C	HP				9 H	our
NoC Archite	strus - Herrera a	Ringro - Alga, energy (and reliability constrain	nts - NoC des	ign lte	ernativ	res
Jali y-	ins (OaS) issues in N	oC prohitectures					
Unit V	EMERCING TRE	NDS				9 H	our
. Fault tolera	nce nause - Ewergin,	or-chip of connection	technologies- 3D NoC	- Simulation			
				Total:		45 H	our
Further Rea	alines						
	in Male	processor System on o	chip (MpSOC)				
	2.NgC	in Real time systems (F	(TS)				
Course Out		in Real time systems (F	(TS)				
Course Out	emes Alter completion of	the course, Student will	be able to				_
Course Out	emes Alter completion of		be able to	work	-044		
Course Out	comes: After completion of Littlemay the majo	the course, Student will	be able to	work			
Course Out	comes: - After completion of - Ademing the majo - Compare differen	the course, student will components required to	be able to desi gn an on-chip net	work			
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Course Out	contest After completion of After completion of After compare different Servature the period Servature the compare the co	the course, Student will components required to synching leahnagues mance of given on chip	be able to design an on-chip net process ock free routing protoco				
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	comes: After completion of Action his the majo Action pare different Servature the period Semon strate the comes.	the course, student will components required to synching lecturques mance of given on chip lead lock free and live lo	be able to c design an on-chip net process ck free routing protoco en on chip network	ls	An E	nginee	rin
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1703EC034	LOW POWER VLSI DESIGN	L	T	P	C
		3	0	0	3
Course Objective					
Iden	ify sources of power in an IC.				
Iden	lify the power reduction techniques based on technology indep	endent and	techr	olog	У
depe	i dent				

Design memory circuits with low power dissipation.		Power dissipation mechanism in various MOS logic style.	
Unit 1		Identify suitable techniques to reduce the power dissipation.	
Hierarchy of limits of power — Sources of power consumption — Physics of power dissipation in CMOS FET devices — Basic principle of low power design. Unit II POWER OF HAZATION 9 Hour Logic level power optimization — Circuit level tow power design — circuit techniques for reducing power consumption in address and multipliers. Unit III DESIGN OF LAW POWER CMOS CIRCUITS 9 Hour Computer at the tooks techniques for low power system — reducing power consumption in memories — low power clock, inter-connect and layout design — Advanced techniques — Special techniques. Unit IV POWER ESTIMATION 9 Hour Power Estimation — Simulation power analysis — Probabilistic power analysis. Unit V SYNTHESIS AND SOFT WARE DESIGN FOR LOW POWER 9 Hours Synthesis for Low power. Further Read ag: Total: 45 Hours Further Read ag:		Design memory curouits with low power dissipation.	
FET devices - Rasic principle of low power design.	Unit	POWER DESIGNATION IN CMOS	9 Hours
That It Proverses - Basic principle of low power design. Unit It Prove FR OPTIMIZATION 9 Hour Logic level power optimization ~ Circuit level low power design ~ circuit techniques for reducing power consumption in address and auctivations. Unit It DESIGN OF LASH POWER CMOS CIRCUITS 9 Hour Computer archivestic techniques for low power system ~ reducing power consumption in memories ~ low power clock. Inter-conject and leyout design ~ Advanced techniques ~ Special techniques. Unit IV POWER ESTEMATION 9 Hour Power Estimation ~ Simulation power analysis ~ Probabilistic power analysis. Onit V SYNTHESIS AND BOTTWARE DESIGN FOR LOW POWER 9 Hours Synthesis for Low power Sahayiotal level transform ~ software design for low power. Total: 45 Hours Further Readurg. Total: 45 Hours Further Readurg. Total: 45 Hours Further Readurg. After a supply for a fifth course. Student will be able to 1. A high the basics and advanced techniques in low power design a sub-vial received in a power dissipation. Total: 4 Analyze Prover Estimation in low power. After access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits. Refers access 1 Card Synthesis the Law Power Circuits Synthesis the Card Synthesis and Circuits Synthesis the Card Synthesis the Card Synthesis a	Hierarchy	of limits of nower - Sources of power consumption - Physics of power dissi	pation in CMOS
Logic level power optimization — Circuit level tow power design — circuit techniques for reducing power consumption in seders and multipliers. Unit 31 DESIGN OF LOW POWER CMOS CIRCUITS 9 Hours Computer arithments techniques for tow power system — reducing power consumption in memories — low power clock, inter-connect and levout design — Advanced techniques — Special techniques. Unit 17 POWER ESTEMATION 9 Hours Power Estimation — Simulation power analysis —Probabilistic power analysis. Unit 1 SYNTHESIS AND SOFTWARE DESIGN FOR LOW POWER 9 Hours Synthesis for law power. Synthesis for law power 9 chevioral level transform — software design for low power. Further Reading. Total: 45 Hours further Reading. After completion of fire course, Student will be able to 1. Alter the basics and advanced techniques in low power design — 2 proofs to recurse and advanced techniques in low power design — 2 proofs to recurse for power dissipation. I Explail the law power Circuits — 4 Analyze Private Estimation in low power 5. Symbosis the Low Power Circuits. Refer: 600: 1 Gary Verb. "Practical lew gover digital VLSI design". Kluwer, 1998. 2. Kaushik Roy and a Carrasad, "Low power CMOS VLSI circuit design", Wiley, 2000. 3. DimitriosSoudria ChiratianPigner, Costas Goutis, "Designing CMOS Circuits for Low Power", Kluwer, 2002. 4. J.B.Kulo and J.F.Luu, "Low voltage CMOS VLSI circuits", Wiley 1999. 5. A.P.A. Condition of the Low Power Choos VLSI Circuits", Wiley 1999. 5. A.P.A. Condition of the Low Power Choos VLSI Circuits", Wiley 1995. 5. A. Adelestiffed over Mchangard Chimasay, "Low power digital VLSI design", Kluwer, 1995. 7. Jennes B.Kulo, Shih-Chia Lin, "Low voltage SOI CMOS VLSI devices and Circuits", John Wiley			
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Unit 101 DESIGN OF LOW POWER CMOS CIRCUITS Computer arithmetic techniques for tow power system — reducing power consumption in memories — low power clock, inter-connect and leyout design — Advanced techniques — Special techniques. Unit IV POWER ESTEMATION 9 Hour Power Listenation — Simulation power analysis — Probabilistic power analysis. Unit V SYNTHESIS AND SOFTWARE DESIGN FOR LOW POWER 9 Hours Synthesis for low power. Total: 45 Hours Further Read signary and Synthesis for low power. Further Read signary 1 miles of the course, student will be able to 1.1 Attent the basics and advanced techniques in low power design process in a properties of the inseparation in low power. After completion of the course, student will be able to 1.1 Attent the basics and advanced techniques in low power design process in a properties of the inseparation in low power. After completion of the course of signation. To plat the inseparation in low power. After accust 1.2 Analyze Power Estimation in low power. Refers accust 1.3 Cary Sear, Process town power CMOS vi.St circuit design", Wiley, 2000. Refers accust 1.4 Cary Sear, Process town power CMOS vi.St circuit design", Wiley, 2000. Dimitrios Soudris Chiration Pigner, Cestar Goutis, "Designing CMOS Circuits for Low Power", Kluwer, 2002. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital CMOS design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital CMOS design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital CMOS design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital CMOS design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital VLSI design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital VLSI design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital VLSI design", Kluwer, 1995. A P.A. bendrasskaran and R. W. Broadersen, "Low power digital VLSI design", Kluwer, 1995.	Logic lev	el power ontimization – Circuit level low power design – circuit techniques for	r reducing power
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Power Estimation techniques - locic power estimation - Simulation power analysis - Probabilistic power analysis. Unit V			
Power Estimation techniques — fosic power estimation — Simulation power analysis — Probabilistic power analysis. Unit V		ck. Inter connect and layout design - Advanced techniques - Special techniques.	
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Synthesis for law power Schavioral level transform - software design for low power. Total: 45 Hours		numerion techniques - logic power estimation — Simulation power analysis —Pro	obabilistic power
Synthesis for law power—Scheviotal level transform – software design for low power. Total: 45 Hours Further Read. ag. Timel 9000 prentitecture, High 9000 for critical paths and low 9000 for non-critical paths. Course Guacemest After a implemental file course, Stadent will be able to 1. know the busics and advanced techniques in low power design 2. not what the busics and advanced techniques in low power design 2. not what the low power CMOS circuits 4. Analyse Power Estimation in low power 5. Synthesis the Low Power Circuits. Refers accus 1. Gard 1 sept. "Practical low power CMOS VLSI circuit design", Wiley, 2000. 3. DimitriosSoudris ChiratianPigner Costas Goutis, "Designing CMOS Circuits for Low Power", Kluwer, 2002. 4. J.B.Kuto and J.F.Lou. "Low voltage CMOS VLSI Circuits", Wiley 1999. 5. A P.C kondrese kersel and R. W. Broedersen, "Low power digital CMOS design", Kluwer, 1995. 6. AbdelstiffBelt over Mahamed J. Elmasry. "Low power digital VLSI design", Kluwer, 1995. 7. James B. Kulo, Shih-Chira Lin, "Low voltage SOI CMOS VLSI devices and Circuits", John Wiley	the second second second second	SANTALES OF TWARF DESIGN FOR LOW POWER	9 Hours
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1703EC035	ANALOG IC DESIGN	L	T	P	C
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Course Objectives:			7115	***	
To im	all knowledge shout the Analog VI St Design.			.,	
	ance the students' knowledge in classical VLSI Design	n			
				-	
Unit 1 MOST	DEVICES AND CIRCUITS			9 H	ours
		1.400	1 1		
Evaluter of 100	viditi deshin ilom x Device modeling -Moore_s la	w- MOS transistors	- depl	etion	and
	VLS) design flow - Device modeling -Moore_s la perations - NMOR and CMOS inverter circuits - Stick				
enhancement mode of	v UST design Now - Device inodeling -Moore_s lar perations - NMOR and CMOS inverter circuits - Stick Rightnessing CiviOS				

NMOS and CMOS fabrication - Newell, Peacell and twin tub processes	
Unit III IMPLEMENTATION STRATEGIES	OTE
PLDs - PAU, PLA, CPLD, Full custom and Semi custom ASIC design- Standard cell design,	9 Hours
block architectures, FPGA interconnect - Routing - FPGA, Xilinx 4000 series - Altera Cyclone	, FPGA building
Unit IV CURRENT TRENDS	
BiCMOS and GaAs devices- introduction to Low power VLSI circuit techniques - Introduction	9 Hours
mixed signal design	on to analog and
Unit V VERILOG HARDWARE DESCRIPTION LANGUAGE	9 Hours
Introduction it Verlag HOL - Echavior modeling Tasks and functions - Verilog struct	ure syntay and
semantics. Generalized a Dataflow growthing Design examples - Adders, Multiples	vers Flin Flons
Registers somares	ters, 1 tip 1 tops,
Total:	45 Hours
Burther Readings	10 220 220
Analog Design Essentials	
Statistic and Frequency Compensation	
Course Ontcorner	
After complete world compact Student will be able to	
Le Explain the operation and characteristics of MOS transistor	
2. Discuss the steps involved in fabrication of IC	767
Och he the role of slick diagram and Layout diagram	
# Discuss the basic concepts of FPGA and ASIC	
I lise the Verliog UDL for digital design	
References	
1 Pucking I Dod and Palmage bulk, "Pasts VI St Designs, PHI publication, Second Edition	2011
2. Charle H. Roth — Child Systems Design Using VHDLI, CL Engineering/Cengage 2012.	Learning India,
3. Samir Panithan Verilog HDL Guide to Digital design and synthesisl, Second .	Edition Pearson
4. M.J. Smith It application specific integrated circuits!, Addison Wesley, 2008.	
 West N and Eshraphiank — Principles of CMOS VLSI Designi, Addison Wesley Pub Edition, 1999. 	lication, Second

1703EC956	MIXED SIGNAL CMOS DESIGN		T	P	C
		3	0	0	3
Course Objections.	1. To know mixed signal circuits like DAC, ADC, I			l'	l
	2. To gain knowledge on filter design in mixed sign 3. To acquire knowledge on design different archite mode		ed sig	gnal	
Unit 1 CMOSA					
	PERMITTER BASICS			9 H	ours
Introduction to MOS odefling such as a second	Capacitances- passive components and their parasitations Single stage and Differential Amplifiers- Curr		d lar		
Introduction to MOS odefling such as a second	Capacitances- bassive components and their parasi		d lar		gna
Introduction to MOS odefling and to a full Telescopic and Folder	Capacitances- passive components and their parasitations Single stage and Differential Amplifiers- Curr	ent Mirrors.	ers –	ge si 9 Ho	gnal ours
Introduction to \$408 odefling and to a \$408 function of the folder of the folder of the frequency response-	Capacitances- bassive components and their parasitable and Single stage and Differential Amplifiers- Current AMPLIFIERS Cascode amplifiers- Siew-rate, Pole splitting-Two-s Statutes, componsation Common mode feedback	ent Mirrors.	ers –	ge si 9 Ho	gnal ours ysis- ifier

E.G.S. PILLAY ENGINEERING COLLEGE

(Autonomous)

Approved by AICTE, New Delhi | Affiliated to Anna University, Chennai Accredited by NAAC with 'A' Grade | Accredited by NBA (CSE, EEE, MECH)

NAGAPATTINAM - 611 002



B.E ELECTRONICS AND COMMUNICATION ENGINEERING

First Year – First Semester

Course Code	Course Name	L	T	P	C	Maximum Marks		
						CA	ES	Total
Theory Cours	e							
1901MA104	Engineering Mathematics –I (Linear Algebra, Calculus and Partial differentiation)	3	1	0	4	40	60	100
1901CH102	Chemistry for Electronic Engineers	3	0	0	3	40	60	100
1901GEX03	Programming for Problem Solving	3	0	0	3	40	60	100
1901ENX01	English for Engineers	2	0	0	2	100		
Laboratory Co	ourse			0	1 4	100		100
1901GEX52	Computer Programming Lab	0	0	2	1	70		
1901GEX51	Engineering Intelligence I	0		2	1	50	50	100
1901CHX51	Engineering Chemistry Lab	-	0	2	1	50	50	100
1901HS151	Communication Skills	0	0	2	1	50	50	100
		0	0	2	1	100	0	100
	Total	11	1	8	16	470	330	800

1901MA104

MATHEMATICS -I (LINEAR ALGEBRA,

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CALCULUS AND PARTIAL DIFFERENTIATION) (Common for ECE, MECH & BME Programme)

MODULE I **MATRICES**

9 Hours

Inverse and rank of a matrix - rank-nullity theorem - System of linear equations - Symmetric-skew-symmetric and orthogonal matrices - Determinants - Eigen values and Eigen vectors-Diagonalization of matrices-Cayley-Hamilton Theorem - Orthogonal transformation.

MODULE II DIFFERENTIAL CALCULUS

Curvature in Cartesian co-ordinates - Centre and radius of curvature - Circle of curvature- Evaluates and involutes.

MODULE III INTEGRAL CALCULUS

Double integration - Cartesian and polar coordinates - Change the order of Integration - Applications: Area of a curved surface using double integral - Triple integration in Cartesian co-ordinates - Volume as triple integral.

MODULE IV SEQUENCES AND SERIES

9 Hours

Convergence of sequence and series-Tests for convergence - Power series - Taylor's series, Series for exponential - trigonometric and logarithm functions.

PARTIAL DIFFERENTIATION

9 Hours

Partial derivatives, total derivative; Maxima, minima and saddle points; Method of Lagrange multipliers.

REFERENCES:

TOTAL: 45 HOURS

- 1. Veerarajan T., Engineering Mathematics for first year, Tata McGraw-Hill, New Delhi, 2018.
- 2. G.B. Thomas and R.L. Finney, Calculus and Analytic geometry, 9th Edition, Pearson, Reprint, 2002.
- 3. Erwin kreyszig, Advanced Engineering Mathematics, 9th Edition, John Wiley & Sons, 2006.
- 4. Ramana B.V., Higher Engineering Mathematics, Tata McGraw Hill New Delhi, 11th Reprint, 2010.
- 5. D. Poole, Linear Algebra: A Modern Introduction, 2nd Edition, Brooks/Cole, 2005.
- 6. N.P. Bali and Manish Goyal, A text book of Engineering Mathematics, Laxmi Publications, Reprint,
- 7. B.S. Grewal, Higher Engineering Mathematics, Khanna Publishers, 36th Edition, 2010

1901CH102

CHEMISTRY FOR ELECTRONIC ENGINEERS

3

MODULE I

(Common for ECE & EEE Programme) Employability Enteneurshi

Electrochemistry- Cell Terminology-Electrochemical cells- Electrolytic cells Cell reactions- Daniel cell-Difference between electrolytic cells and electrochemical cells. Reversible cells and irreversible cells -types-EMF and its applications - Nernst equation (derivation and problems). Single electrode potential - Hydrogen electrode - Calomel electrode - Glass electrode - pH measurement using glass electrode.

MODULE II

Semiconductors- Conductors, insulators, semiconductors, - Band theory semiconductors - Junction devices -Super conductivity - Ionic conductivity - defects in stoichiometric and Non stoichiometric crystals. Optical properties of solids - Lasers and phosphors - Photovoltaic effect- Solar energy storage and conversion

MODULE III

Materials for communications - crystalline semiconductors; metalized film conductors; dielectric films; solders; ceramics and polymers. Electronic materials, Semiconductor crystals - Silicon, III-V compounds, Photoresist films, Packaging materials, Photonic materials, Crystalline materials - Epitaxial layers, Optical switching, Optical transmission-NLO and OLED Materials.

MODULE IV

9 Hours

Biosensors- biosensors -types of biosensors- magnetic biosensors, thermal biosensors- piezoelectric biosensorsoptical biosensors - applications of biosensor. introduction: classification of polymers - natural and synthetic; thermoplastic and thermosetting. conducting polymers, electron conducting polymers- polyaniline (pan), polypyrroles (ppy), polythiophenes (pt) and polyphenylene vinylenes (ppv) - light emitting diodes , photo-induced doping.

MODULE V

Nanotechnology - Basics - distinction between molecules, nanoparticles and bulk materials; size-dependent properties. Nanoparticles: nano cluster, nano rod, nanotube (CNT) and nanowire. Synthesis: precipitation, thermolysis, hydrothermal, solvothermal, electrodeposition, chemical vapour deposition, laser ablation; Properties and applications.

TOTAL: 45 HOURS

REFERENCES:

- 1. Dara S.S, Umare S.S, "Engineering Chemistry", S. Chand & Company Ltd., New Delhi 2010.
- 2. Sivasankar B., "Engineering Chemistry", Tata McGraw-Hill Publishing Company, Ltd., New delhi
- 3. Gowariker V.R., Viswanathan N.V. and Jayadev Sreedhar, "Polymer Science", New Age .
- 4. Ozin G. A. and Arsenault A. C., "Nanochemistry: A Chemical Approach to Nanomaterials", RSC
- 5. Biosensors: An Introductory Textbook by C. S. Pundir and Jagriti Narang,2017
- 6. J.O.M.Bockris & A.K.N.Reddy, "Modern Electrochemistry -Vol. I & II", Plenum Press, New York,
- 7. Peter Atkins and Julio de Paula, "Physical Chemistry", VII Edition, Oxford University Press, New
- 8. A.J. Bard and L.R. Faulkner, "Electrochemical Methods Fundamentals and applications" 3 rd edition John Wiley & Sons Inc, 2001.

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PROGRAMMING FOR PROBLEM SOLVING L T \mathbf{C} (Common for all B.E./B.Tech Programme) 3 3

1901GEX03

MODULE I INTODUCTION TO PROGRAMM

9 Hours

Components of Computers and its Classifications- Problem Solving Techniques - Algorithm- Flowchart-Pseudo code - Program-Compilation - Execution

MODULE II BASICS OF C PROGRAMMING

Structure of C program - C programming: Data Types - Storage classes - Constants - Enumeration Constants -Keywords - Operators: Precedence and Associativity - Expressions - Input/output statements - Decision making statements - Switch statement - Looping statements - Pre-processor directives.

MODULE III ARRAYS AND STRINGS

9 Hours

Introduction to Arrays: Declaration, Initialization - One dimensional array - Two dimensional arrays - Example Program: Matrix Operations - String operations

MODULE IV FUNCTIONS AND POINTERS

9 Hours

Introduction to functions: Function prototype, function definition, function call, Built-in functions - Recursion -Example Program - Pointers - Pointer operators - Pointer arithmetic - Arrays and pointers - Array of pointers -Example Program: Sorting of names - Parameter passing: Pass by value, Pass by reference - Example Program: Swapping of two numbers and changing the value of a variable using pass by reference

MODULE V STRUCTURES & FILE PROCESSING

Structure - Nested structures - Pointer and Structures - Array of structures - Example Program using structures and pointers - Dynamic memory allocation -Files - Types - File processing: Sequential access, Random access -Command line arguments

TOTAL: 45 HOURS

REFERENCES:

- 1. Paul Deitel and Harvey Deitel, —C How to Programl, Seventh edition, Pearson Publication
- 2. Juneja, B. L and Anita Seth, —Programming in Cl, CENGAGE Learning India pvt. Ltd., 2011
- 3. Pradip Dey, Manas Ghosh, -Fundamentals of Computing and Programming in CI, First Edition, Oxford University Press, 2009.
- 4. Anita Goel and Ajay Mittal, —Computer Fundamentals and Programming in Cl, Dorling Kindersley (India) Pvt. Ltd., Pearson Education in South Asia, 2011.
- 5. Byron S. Gottfried, "Schaum's Outline of Theory and Problems of Programming with C", McGraw-Hill Education, 1996.

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1901ENX01

ENGLISH FOR ENGINEERS

C

(Common for all B.E./B.Tech. Programme)

3

(Kill Developmen FOCUS ON LANGUAGE (Vocabulary and Grammar) MODULE I

9 Hours

Vocabulary -The Concept of Word Formation - prefixes- suffixes- Synonyms ✓ Antonyms - Grammar -Articles-Preposition- Adjective-Adverb-connectives -Tenses (present, past & future) - Sentence pattern- types of sentences -Active voice -passive voice and Impersonal passive voice - Wh- Questions.

MODULE II LISTENING SKILLS

9 Hours

Listening- listening intently-arousing and sustaining interest-listening to short or longer texts- formal and informal conversations- telephonic etiquettes- narratives from different sources. -listening and Note takingcorrelative verbal and nonverbal communication-listening to TOEFL & IELTS programs-listening to presentation- listening to technical seminar and conferences. Project

MODULE III SPEAKING SKILLS

9 Hours

Speaking - stress and intonation -persuasive speaking -Describing person, place and thing - sharing information — greetings —taking leave -Individual and Group Presentation-impromptu personal Presentation-public speaking-Group Discussion- project planning-facing viva voce and delivering project.

MODULE IV READING SKILLS

9 Hours

Reading- comprehending general and technical articles -cloze reading - inductive reading- short narrative and descriptions from newspapers - Skimming and scanning-reading and interpretation-critical reading interpreting and transferring graphical information- sequencing of sentences-analytical reading on various Projects.

MODULE V WRITING SKILLS

9 Hours

Writing- Precise writing -Summarizing- interpreting visual texts (pie chart, bar chart, picture advertisements etc., - Proposal writing (launching new units or department in a institution or industry & to get loan from bank) -report writing (accident, progress, project, survey, Industrial visit)- job applicatione-mail drafting- letter writing (permission, accepting and decaling)-instructions recommendations -checklist

TOTAL: 45 HOURS

REFERENCES:

- 1. Raman, Meenakshi and Sangeetha Sharma, "Technical Communication: Principles and Practice", Oxford University Press, New Delhi, 2011.
- 2. Rizvi and Ashraf M., "Effective Technical Communication", Tata McGraw-Hill, New Delhi, 2005.
- 3. G. Radhakrishna Pillai, "English for Success", Central Institute of English and Foreign Languages", Emerald Publishers ,Hyderabad, 2003
- 4. Jones, D, "The Pronunciation of English", CUP, . Cambridge, 2002.

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1901GNX51

ENGINEERING INTELLIGENCE I (Common for all B.E./B.Tech. Programme)

 \mathbf{L} \mathbf{C} 0 1

BEHAVIORAL CHANGES - TRANSITION OF MODULE I SCHOOL TO 6 Hours COLLEGE

Vocabulary -The Concept of Word Formation - prefixes- suffixes- Synonyms - Antonyms - Grammar -Articles-Preposition- Adjective-Adverb-connectives -Tenses (present, past & future) - Sentence patterntypes of sentences -Active voice -passive voice and Impersonal passive voice - Wh- Questions.

MODULE II EXPOSURE TO INDIVIDUAL COMPETANCE

6 Hours

Listening- listening intently-arousing and sustaining interest-listening to short or longer texts- formal and informal conversations- telephonic etiquettes- narratives from different sources. -listening and Note taking- correlative verbal and nonverbal communication-listening to TOEFL & IELTS programs-listening to Project presentation-listening to technical seminar and conferences.

MODULE III CAREER PLANNING

6 Hours

Speaking - stress and intonation -persuasive speaking -Describing person, place and thing - sharing personal information — greetings leave -Individual and Group Presentation-impromptu -taking Presentation-public speaking-Group Discussion- project planning-facing viva voce and delivering project.

MODULE IV INTRODUCTION TO COMMUNICATION SKILLS

Reading- comprehending general and technical articles -cloze reading - inductive reading- short narrative and descriptions from newspapers - Skimming and scanning-reading and interpretation-critical reading interpreting and transferring graphical information- sequencing of sentences-analytical reading on various Projects.

MODULE V COMMUNICATION EXERCISE-1

6 Hours

Writing- Precise writing -Summarizing- interpreting visual texts (pie chart, bar chart, picture advertisements etc., - Proposal writing (launching new units or department in a institution or industry & to get loan from bank) -report writing (accident, progress, project, survey, Industrial visit)- job application-e-mail drafting- letter writing (permission, accepting and decaling)-instructions recommendations -checklist

TOTAL: 30 HOURS

REFERENCES:

- Dr.P.Prasad(2012) "The Functional Aspects of COMMUNICATION SKILLS"; fifth Edition; S.K Kataria & Sons Publication
- Kalyana; (2015) "Soft Skill for Managers"; First Edition; Wiley Publishing Ltd. 2.
- Aruna Koneru (2008) "Professional Communication"; Second edition; Tata McGraw-Hill 3. Publishing Ltd.

1901HS151

COMMUNICATION SKILLSLAB (Common for all B.E./B.Tech. Programme)

List of Experiments:

1. Activities on Fundamentals of Inter-personal Communication

Starting a conversation - responding appropriately and relevantly - using the right body language - Role Play in different situations & Discourse Skills- using visuals.

2. Activities on Reading Comprehension

General Vs Local comprehension, reading for facts, guessing meanings from context, Scanning, skimming, and inferring meaning, critical reading & effective googling.

3. Activities on Writing Skills

Structure and presentation of different types of writing - letter writing/ Resume writing/ecorrespondence/ Proposal writing/Technical report writing/ Portfolio writing - planning for writing improving one's writing.

4. Activities on Presentation Skills

Oral presentations (individual and group) through JAM sessions / seminars / PPTs and written presentations through posters/ projects/ reports/ e-mails/ assignments etc.- creative thinking.

5. Activities on Soft Skills

Dynamics of group discussion, intervention, summarizing, modulation of voice, body language, relevance, fluency and organization of ideas and rubrics for evaluation-Concept and process, preinterview planning, opening strategies, answering strategies, interview through tele-conference & video-conferencing and Mock Interviews-Timemanagement-stress management -paralinguistic features- Multiple intelligences - emotionalintelligence - spiritual quotient (ethics) - intercultural communication - creative and critical.

> Total: 45 Hours

References:

- 1. Raman, Meenakshi and Sangeetha Sharma, "Technical Communication: Principles and Practice", Oxford University Press, New Delhi, 2011.
- 2. Sudha Rani, D, "Advanced Communication Skills Laboratory Manual", Pearson Education 2011.
- 3. Paul V. Anderson, "Technical Communication", Cengage Learning pvt. Ltd. New Delhi, 2007.
- 4. "English Vocabulary in Use series", Cambridge University Press 2008.
- 5. "Management Shapers Series", Universities Press (India) Pvt Ltd., Himayatnagar, Hyderabad
- 6. Rizvi and Ashraf M., "Effective Technical Communication", Tata McGrawHill, New Delhi, 2005.
- 7. Jones, D, "The Pronunciation of English", CUP, . Cambridge, 2002.

E.G.S. PILLAY ENGINEERING COLLEGE

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NAGAPATTINAM - 611 002



B.E ELECTRONICS AND COMMUNICATION ENGINEERING

First Year - Second Semester

Course Code	ourse Hame	L	T	P	C	Maximum Marks		
						CA	ES	Total
Theory Cours	se							
1901MA204	Engineering Mathematics –II (Calculus, Ordinary Differential Equations and Complex Variable)	3	2	0	4	40	60	100
1901PH202	Semiconductor Physics and Optoelectronics	3	0	0	3	40	60	100
1901GEX01	Basic Electrical and Electronics Engineering	3	0	0	3	40	60	100
1901GEX02	Engineering Graphics	2	2	0	-	50		
1901GE201	Engineering Exploration	2	0		3	50	50	100
Laboratory Co	ourse		U	0	2	40	60	100
1901GE254	Computer Hardware and IT Essentials Lab	0	0	2	1	50	50	100
1901GE252	Engineering Intelligence - II	0	0	2	1	100	-	100
1901GEX51	CAD Lab	0	0	2		100	0	100
1901GEX53	Basic Electrical and Electronics Engineering Lab	0	0	2	1	50	50	100
1901PHX51	Engineering Physics Lab	0	0	2	1	50	50	100

1901CHX51 ENGINEERING CHEMISTRY LAB P \mathbf{C} (Common for all B.E./B.Tech. Programme) 2 1

List of Experiments:

- 1. Determination of total, temporary & permanent hardness of water by EDTA method
- 2. Determination of strength of given hydrochloric acid using pH meter
- 3. Estimation of iron content of the given solution using potentiometer
- 4. Estimation of sodium present in water using flame photometer
- 5. Corrosion experiment weight loss method
- 6. Determination of molecular weight of a polymer by viscometer method
- 7. Conductometric titration of strong acid Vs strong Base
- 8. Estimation of dissolved oxygen in a water sample/sewage by Winkler's method.
- 9. Comparison of alkalinities of the given water samples
- 10. Determination of concentration of unknown colored solution using spectrophotometer
- 11. Determination of percentage of copper in alloy
- 12. Determination of ferrous iron in cement by spectrophotometry method
- 13. Adsorption of acetic acid on charcoal
- 14. Determination the flash point and fire point of a given oil using pen skyMartine closed cup apparatus
- 15. Determination the calorific value of solid fuels
- 16. Determination the structural of the compound using chemo software.

References:

1. Furniss B.S. Hannaford A.J, Smith P.W.G and Tatchel A.R., "Vogel"s Textbook of practical organic chemistry", LBS Singapore (1994).

Total:

45 Hours

2. Jeffery G.H., Bassett J., Mendham J.and Denny vogel"s R.C, "Text book of quantitative analysis chemical analysis", ELBS 5th Edn. Longman, Singapore publishers, Singapore, 1996.

3. Daniel R. Palleros, "Experimental organic chemistry" John Wiley & Sons, Inc., New Yor (2001).

4. Kolthoff I.M., Sandell E.B. et al. "Quantitative chemical analysis", Mcmillan, Madras 1980.

1901MA204

ENGINEERING MATHEMATICS – II

(Calculus, Ordinary Differential Equations and Complex Variable)

MODULE I

LAPLACE TRANSFORM SKII DEVELOPMEN enew S 12 Hours Laplace Transform - Conditions for existence - Transform of Elementary Functions - Basic Properties -Transform of Unit step function and Impulse function - Transform of Periodic function - Inverse Laplace Transform - Convolution Theorem (excluding Proof) - Initial and Final value Theorems - Solution of Linear ODE of Second order with constant coefficient using Laplace Transform techniques.

MODULE II **VECTOR CALCULUS**

12 Hours

Gradient, Divergence and Curl - Directional derivative - Irrotational and solenoidal vector fields - Vector integration: Green"s theorem in a plane, Gauss divergence theorem and Stokes" theorem (excluding proofs) -Applications of the above theorems to find surface area of a closed region and volume of cube and parallel piped.

MODULE III ORDINARY DIFFERENTIAL EQUATIONS

12Hours

Second order linear differential equations with variable coefficients, method of variation of parameters.

COMPLEX VARIABLE - DIFFERENTIATION MODULE IV

12Hours

Cauchy-Riemann equations, analytic functions, harmonic functions, finding harmonic conjugate; Conformal mappings, Mobius transformations.

MODULE V COMPLEX VARIABLE-INTEGRATION

12 Hours

Contour integrals, Cauchy Integral formula (without proof), Taylor's series, zeros of analytic functions, singularities, Laurent's series; Residues, Cauchy Residue theorem (without proof), Evaluation of definite integral involving sine and cosine, Evaluation of certain improper integrals using the Bromwich contour.

TOTAL: 60 HOURS

REFERENCES:

- 1. G.B. Thomas and R.L. Finney, Calculus and Analytic geometry, 9th Edition, Pearson, Reprint, 2002.
- 2. Erwin kreyszig, Advanced Engineering Mathematics, 9th Edition, John Wiley & Sons, 2006.
- 3. W. E. Boyce and R. C. DiPrima, Elementary Differential Equations and Boundary Value Problems, 9th Edn., Wiley India, 2009.
- 4. S. L. Ross, Differential Equations, 3rd Ed., Wiley India, 1984.
- 5. J. W. Brown and R. V. Churchill, Complex Variables and Applications, 7th Ed., McGraw Hill, 2004.
- 6. N.P. Bali and Manish Goyal, A text book of Engineering Mathematics, Laxmi Publications, Reprint, 2008.
- 7. B.S. Grewal, Higher Engineering Mathematics, Khanna Publishers, 36th Edition, 2010.

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SEMICONDUCTOR PHYSICS AND OPTOELECTRONICS L \mathbf{T} \mathbf{C} 1901PH202 3 3

MODULE I ELECTRONIC MATERIALS

9 Hours

Free electron theory, Density of states and energy band diagrams, Energy bands in solids, E-k diagram, Direct and indirect bandgaps, Types of electronic materials: metals, semiconductors and insulators, Occupation probability, Fermi level.

MODULE II SEMICONDUCTORS Entreplements hif 9 Hours
Intrinsic and extrinsic semiconductors, Dependence of Fermi level on carrier- concentration and temperature (equilibrium carrier statistics), Carrier generation and recombination, Carrier transport: diffusion and drift, p-n junction, Metal- semiconductor junction (Ohmic and Schottky). Entrepreneurship

MODULE III SEMICONDUCTOR LASERS

Optical transitions in bulk semiconductors: absorption, spontaneous emission, and stimulated emission; Density of states for photons, Transition rates (Fermi's golden rule), Optical loss and gain. Semiconductor laser (GaAs): materials, device characteristics, figures of merit and Vertical-Cavity Surface-Emitting Lasers (VECSEL), Tunable semiconductor lasers.

MODULE IV SEMICONDUCTOR PHOTODETECTORS

Types of semiconductor photodetectors -p-n junction, PIN, and Avalanche and their structure, working principle, and characteristics, Noise limits on performance; Solar cells.

MODULE V NANO- OPTOELECTRONIC DEVICES

9 Hours

Digital systems: Boolean algebra - Reduction of Boolean expressions - De-Morgan"s theorem - Logic gates -Implementation of Boolean expressions.

TOTAL: 45 HOURS

REFERENCES:

- 1. J. Singh, Semiconductor Optoelectronics: Physics and Technology, McGraw-Hill Inc. (1995).
- 2. B. E. A. Saleh and M. C. Teich, Fundamentals of Photonics, John Wiley & Sons, Inc., (2007).
- 3. S. M. Sze, Semiconductor Devices: Physics and Technology, Wiley (2008).
- 4. A. Yariv and P. Yeh, Photonics: Optical Electronics in Modern Communications, Oxford University Press, New York (2007).
- 5. P. Bhattacharya, Semiconductor Optoelectronic Devices, Prentice Hall of India (1997).
- 6. Online course: "Semiconductor Optoelectronics" by M R Shenoy on NPTEL
- 7. Online course: "Optoelectronic Materials and Devices" by Monica Katiyar and Deepak Gupta on NPTEL

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1901GEX01 BASIC ELECTRICAL AND ELECTRONICS ENGINEERING L T P C

3 0 0 3

MODULE I INTRODUCTION TO DC AND AC CIRCUITS

7 Hours

Introduction to DC and AC circuits: Ohms law - Kirchhoff's laws - Mesh analysis - Nodal analysis - Generation of AC waveforms - Analysis of R-L, R-C, R-L-C circuits - Introduction to three phase systems - Types of connections.

MODULEII ELECTRICAL MACHINES

6 Hours

Electrical Machines: DC Generator, DC Motor, Transformer, Induction Motor: Working principle, construction and applications.

MODULEIII MEASURING INSTRUMENTS

6 Hours

Measuring instruments: Classification of instruments; Voltmeter, Ammeter, Wattmeter, Energy meter, Multimeter, CRO: Principles and operation.

MODULEIV SEMICONDUCTOR DEVICES

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7 Hours

Semiconductor devices: V-I characteristics of PN junction diode and Zener diode; Rectifiers - Half wave and full wave rectifiers; BJT - configurations; Amplifiers & Oscillators: classification, operation and applications; SCR: Construction and V-I characteristics; Basic power converters (Block diagram approach only).

MODULEV DIGITAL SYSTEMS

6 Hours

Digital systems: Boolean algebra - Reduction of Boolean expressions - De-Morgan's theorem - Logic gates - Implementation of Boolean expressions.

MODULEVI COMMUNICATION SYSTEMS

6 Hours

Communication Systems: Model of communication system - Analog and digital, Wired and wireless channel - Block diagram of various communication systems - Microwave, satellite, optical fiber and cellular mobile system.

MODULEVII ELECTRICAL SAFETY AND WIRING

7 Hours

Electrical safety and wiring: Safety measures in electrical system - Safety devices - types of wiring - Wiring accessories- staircase, fluorescent lamps and corridor wiring - Basic principles of earthing - Types of earthing - layout of generation, transmission and distribution of power (Single line diagram).

TOTAL: 45 HOURS

REFERENCES:

- 1. Smarajit Ghosh, "Fundamentals of Electrical and Electronics Engineering", 2nd Edition, PHI Learning, 2010.
- 2. R. Muthusubramaniam, S. Salaivahanan and K.A. Mureleedharan, "Basic Electrical Electronics and Computer Engineering", Tata McGraw Hill, 2004.
- 3. D.P. Kothari and I.J. Nagrath, "Theory and Problems of Basic Electrical Engineering", PHI learning, New Delhi, 2004
- 4. J.B. Gupta, "Fundamentals of Electrical Engineering and Electronics", S.K. Kataria and Sons, Reprint 2012 Edition.
- 5. R.L. Boylestad and L. Nashelsky, "Electronic Devices and Circuit Theory", Pearson, 11th Edition, 2013.
- 6. George Kennedy and Bernard Davis, "Kennedy"s Electronic communication Systems", McGraw Hill Education, 5th Edition, 2011.

7. Donald P. Leach, Albert Paul Malvino and Goutam Saha, "Digital Principles and Applications", McGraw-Hill Education, 8th Edition, 2014.

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Page I A

1901GEX02

ENGINEERING GRAPHICS

L T P C 2 2 0 3

MODULE I CONCEPTS AND CONVENTIONS (Not for Examination)

5 Hours

Importance of graphics in engineering applications – Use of drafting instruments – BIS conventions and specifications – Size, layout and folding of drawing sheets – Lettering and dimensioning.

MODULEII PLANE CURVES AND FREE HAND SKETCHING

9 Hours

Basic Geometrical constructions, Curves used in engineering practices: Conics – Construction of ellipse, parabola and hyperbola by eccentricity method – Construction of cycloid – construction of involutes of square and circle – Drawing of tangents and normal to the above curves.

Visualization concepts and Free Hand sketching: Visualization principles –Representation of Three-Dimensional objects – Layout of views- Free hand sketching of multiple views from pictorial views of Objects.

MODULEIII PROJECTION OF POINTS, LINES AND PLANE SURFACES

9 Hours

Orthographic projection- principles-Principal Planes-First angle projection-projection of points. Projection of straight lines (only First angle projections) inclined to both the principal planes - Determination of true lengths and true inclinations by rotating line method and traces. Projection of planes (polygonal and circular surfaces) inclined to both the principal planes by rotating object method.

MODULEIV PROJECTION OF SOLIDS

9 Hours

Projection of simple solids like prisms, pyramids, cylinder and cone when the axis is inclined to one of the principal planes by rotating object method.

MODULE V PROJECTION OF SECTIONED SOLIDS AND DEVELOPMENT OF 9 Hours SURFACES

Sectioning of above solids in simple vertical position when the cutting plane is inclined to the one of the principal planes and perpendicular to the other – obtaining true shape of section. Development of lateral surfaces of simple and sectioned solids – Prisms, pyramids cylinders and cones.

MODULE VI ISOMETRIC AND PERSPECTIVE PROJECTIONS

9 Hours

Principles of isometric projection – isometric scale –Isometric projections of simple solids and truncated solids - Prisms, pyramids, cylinders, cones- combination of two solid objects in simple vertical positions and miscellaneous problems. Perspective projection of simple solids-Prisms, pyramids and cylinders by visual ray method.

TOTAL: 45+5 HOURS

REFERENCES:

- 1. Gopalakrishna K.R., "Engineering Drawing" (Vol. I&II combined), Subhas Stores, Bangalore, 2016.
- 2. Luzzader, Warren.J. and Duff, John M., "Fundamentals of Engineering Drawing with an introduction to Interactive Computer Graphics for Design and Production, Eastern Economy Edition, Prentice Hall of India Pvt. Ltd, New Delhi, 2005.
- 3. Shah M.B., and Rana B.C., "Engineering Drawing", Pearson, 2nd Edition, 2015.
- 4. Venugopal K. and Prabhu Raja V., "Engineering Graphics", New Age International (P) Limited, 2017.
- 5. Natrajan K.V., "A text book of Engineering Graphics", Dhanalakshmi Publishers, Chennai, 2015.
- 6. Basant Agarwal and Agarwal C.M., "Engineering Drawing", Tata McGraw Hill Publishing Company Limited, New Delhi, 2008.
- 7. Bhatt N.D. and Panchal V.M., "Engineering Drawing", Charotar Publishing House, 50th Edition, 2016.

1901GE201

ENGINEERING EXPLORATION

L T P C 2 0 0 2

What is Engineering: Engineering Requirement, Knowledge within Engineering disciplines, Engineering advancements

Engineering Design: Problem definition, idea generation through brainstorming and researching, solution creation through evaluating and communicating, text/analysis, final solution and design improvement.

Defining problems and Brainstorming: Researching design, sketching problem solving.

Communicating solution: Dimensioning orthographic drawing, perspective drawing.

Modeling and Testing final output: Product evaluation, reverse engineering, final project report.

Civil Engineering: Structural forces structural analysis, bridge design components, structural design.

Mechanical Engineering: Types of motion, mechanical power system, mechanical power formula, mechanical design.

Electrical Engineering: Reading analog multimeter, measuring current, voltage and resistance, electricity from chemicals, solar cells, magnets, Ohms law and watts law, circuit identification and circuit calculation, resistor color code, continuity.

Computer Engineering: Logic gates, algorithms, computer architecture, binary code.

TOTAL: 30 HOURS

REFERENCES:

- 1. Ryan A.Brown, Joshua W.Brown and Michael Berkihiser: "Engineering Fundamentals: Design, Principles, and Careers", Goodheart-Willcox Publisher, Second Edition, 2014.
- 2. Saeed Moaveni, "Engineering Fundamentals: An Introduction to Engineering", Cengage learning, Fourth Edition, 2011.

1901GE254 COMPUTER HARDWARE AND IT ESSENTIALS LAB L T P C 0 0 2 1

List of Experiments:

- 1. Study of hardware components (such as storage devices, I/O devices, CPU, Motherboard, other peripherals).
- 2. Installation of operating systems (Windows and Linux).
- 3. Other software installation.
- 4. Study of network components.
- 5. Network establishment(configuring IP address, Domain name system)
- 6. Study of Internet.
- 7. Introduction to Web.
- 8. Usage of internet services- Email, File Sharing, Social Media etc.
- 9. Study of firewalls and Antivirus.
- 10. Troubleshooting various problems.

Skill Development

TOTAL: 30 HOURS

REFERENCES:

- 1. Craig Zacker& John Rourke, "The complete reference:PC hardware", Tata McGrawHill, New Delhi, 2001.
- 2. Mike Meyers, "Introduction to PC Hardware and Troubleshooting", Tata McGrawHill, New Delhi, 2003.
- 3. B.Govindarajulu, "IBM PC and Clones hardware trouble shooting and maintenance".
- 4. Tata McGraw-Hill, New Delhi, 2002
- 5. R. Kelly Rainer, Casey G. Cegielski, Brad Prince, Introduction to Information Systems, Fifth Edition, Wiley Publication, 2014.
- 6. James F. Kurose, —Computer networking: A Top-Down Approach!, Sixth Edition, Pearson, 2012.
- 7. R. Kelly Rainer, Casey G. Cegielski, Brad Prince, Introduction to Information Systems, Fifth Edition, Wiley Publication, 2014
- 8. Craig Zacker& John Rourke, "The complete reference:PC hardware", Tata McGrawHill, New Delhi, 2001.

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ENGINEERING INTELLIGENCE II

L T P C 0 0 2 1

Skill Development

MODULE I VOCABULARY BULIDING

6 Hours

Parts of Grammar-SVA-Art of Writing-word building activities

MODULEII COMMUNICATION WORKSHOP

6 Hours

Story Telling- Newspaper Reading-Extempore.

MODULEIII INTERPERSONAL SKILLS

6 Hours

Personality Development - Creativity and innovation - Critical Thinking and Problem Solving - Work Ethics-Technical Skill Vs Interpersonal Skills

MODULEIV LEADERSHIP& EMPLOYABILITY SKILLS

6 Hours

Levels of Leadership-Making of leader-Types of leadership-Transactions Vs Transformational Leadership – Exercises - Industry Expectations & Career Opportunities- Recruitment patterns.

MODULE V RESUME BUILDING

6 Hours

Importance of Resume-Resume Preparation - introducing onself

TOTAL: 30 HOURS

REFERENCES:

- 1. Barun K. Mitra; (2011), "Personality Development & Soft Skills", First Edition; Oxfor Publishers.
- 2. Raymond Murphy, Essential English Grammar in Use, Cambridge University press, New Delhi, Third Edition, 2007.
- 3. Arun Sharma and Meenakshi Upadhyav, How to Prepare for Verbal Ability and Reading Comprehension for CAT, McGrawHill Publication, Seventh Edition 2017.

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1901GEX51

CAD (COMPUTER AIDED DRAFTING) LAB

L T P C 10 0 2 1

List of Experiments:

Basics commands of a CAD software- two-dimensional drawing, editing, layering and dimensioning - coordinate Systems-Drawing practice - orthographic views of simple solids using CAD software.

- 1. Study of capabilities of software for Drafting and Modeling Coordinate systems (absolute, relative, polar, etc.) Creation of simple figures like polygon and general multi-line figures.
- 2. Drawing of a Title Block with necessary text and projection symbol.
- 3. Drawing of curves like parabola, spiral, involute using B-spline or cubic spline.
- 4. Drawing of front view and top view of simple solids like prism, pyramid, cylinder, cone, etc, and dimensioning.
- 5. Drawing front view, top view and side view of objects from the given pictorial views (eg. V-block, Base of a mixie, Simple stool, Objects with hole and curves).
- 6. Drawing sectional views of prism, pyramid, cylinder, cone, etc,
- 7. Drawing isometric projection of simple objects.
- 8. Creation of 3-D models of simple objects and obtaining 2-D multi-view drawings from 3-D model.

TOTAL: 30 HOURS

- 1. N.D. Bhatt, Machine Drawing, Charotar Publishing House Pvt. Ltd., 2014.
- 2. P.S. Gill, A Textbook of Machine Drawing, Katson books, 2013.
- 3. R.K. Dhawan, A Textbook of Machine Drawing, S. Chand, 2012.
- 4. K.C. John, Textbook of Machine Drawing, PHI Learning Pvt. Ltd., 2009.

1901GEX53 BASIC ELECTRICAL AND ELECTRONICS L T P C ENGINEERING LABORATORY 0 0 2 1

List of Experiments:

- 1. Experiments related to verification of Ohm"s law and Kirchhoff"s laws
- 2. Experiments involving logic gates
- 3. Fan and light control using regulators
- 4. Design of 6V regulated power supply
- 5. Energy conservation demonstration experiment using energy meter
- 6. Waveform generation and calculation of RMS and average values
- 7. IC 555 and IC 741 based experiments
- 8. Experiments in earthing
- 9. Staircase wiring and residential building wiring
- 10. Speed control of DC shunt motor

Total: 30 Hours

- 1. Edward Hughes, "Electrical Technology,", Pearson Education
- 2. D.P. Kothari and Nagrath" Basic Electronics", MH Education 2013.
- 3. Paul Scherz and Simon Monk "Practical Electronics for inventors" Mc Graw Hill Publications 2013.

1901PHX51

ENGINEERING PHYSICS LAB

L T P C 0 0 2 1

List of Experiments:

- 1. Determination of wavelength of various colours of mercury spectrum using Laser grating
- 2. Determination of velocity of liquids using ultrasonic interferometer
- 3. Determine the dispersive power of a prism using spectrometer
- 4. Determine the unknown resistance of the given wire using Carey-Foster"s Bridge
- 5. Determine the band gap of the given semiconductor
- 6. Determine the acceptance angle and particle size using Laser
- 7. Torsional pendulum Rigidity modulus of a steel wire
- 8. Thickness of a thin wire Air Wedge
- 9. Measurement of Young"s modulus Uniform and Non-uniform bending
- 10. Thermal conductivity -Lee"s Disc method

Total: 45 Hours

- 1. "Practical Physics", R.K. Shukla, Anchal Srivastava, New age international (2011)
- 2. "B.Sc. Practical Physics", C.L Arora, S. Chand &Co. (2012)

E.G.S.PILLAY ENGINEERING COLLEGE

(Autonomous)

Approved by AICTE, New Delhi | Affiliated to Anna University, Chennai Accredited by NAAC with "A"Grade | Accredited by NBA (CSE, EEE, MECH, ECE, CIVIL, IT) NAGAPATTINAM—611002



B.E ELECTRONICS AND COMMUNICATION ENGINEERING

Full Time Curriculum and Syllabus

Third Year - Fifth Semester

Course Code	Course Name	L	T	P	C	Maxin	ırks	Category	
Theory Cour	rse					CA	ES	Total	
	Analog Communication								
1902FC502	Distract Co. L.D.	3	()	0	3	40	60	100	PCC
	Digital Signal Processing	2	2	0	3	40	1		
1902EC503	Transmission Lines and Wave guides	2		-			60	100	PCC
1902EC504	Control Systems		2	0	3	40	60	100	PCC
		2	2	0	3	40	60	100	PCC
1902EC505	Computer Networks	2	-		-)	100	
	Professional Elective – I		U	0	2	40	60	100	PCC
aboratory C	Course	3	()	0	3	40	60	100	PEC
	Digital Signal Processing Laboratory								30
1902EC552	Computer Networks Laboratory	0	0	2	I	50	50	100	PCC
	Life Stilles And Laboratory	0	0	2	1	50	50	100	PCC
Audit Course	Life Skills: Aptitude I	2	0	0	1	100		100	
								100	EEC
	Essence of Indian Traditional Knowledge	2	()	0	0	100	_	100	MC
	Total	18	6	4	20	540	460	1000	

ANALOG COMMUNICATION

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MODULE 1 AMPLITUDE MODULATION

9 Hours

Introduction to communication systems - Modulation - Need for modulation - Classifications of modulation techniques - Amplitude Modulation - Generation and Detection of AM - Transmitters and Receivers of AM -Super heterodyne receiver - Double Side Band Suppressed Carrier (DSBSC) systems generation and detection - Single Side Band (SSB) systems - SSB-SC generation and detection, Vestigial Side Band (VSB) - Comparison of various AM systems.

MODULE II

ANGLE MODULATION

9 Hours

Frequency modulation: Narrowband and wideband FM - Generation of FM signal: Direct FM, indirect FM - Demodulation of FM signals using detectors - FM transmitters - FM receivers - Phase Modulation -Phase Locked Loop - Comparison of AM,FM and PM.

MODULE III NOISE IN COMMUNICATION SYSTEM

9 Hours

Noise sources and types - External Noise - Internal Noise - Noise calculation - Noise figure - Noise temperature - Noise equivalent bandwidth - Narrowband noise - PSD of in-phase and quadrature noise -Noise in AM receivers - Noise in FM receivers - Pre-emphasis and de-emphasis in FM system - Capture effect and threshold effect - Comparison of noise performance of AM and FM systems.

MODULE IV PULSE MODULATION AND SAMPLING

9 Hours

PAM - PWM - PPM - Comparison of Pulse modulation - Time Division Multiplexing - Frequency Division Multiplexing - Pulse Time Modulation systems: Generation and detection - Sampling Process: Sampling of Band limited signals - Ideal and practical sampling - Anti aliasing and reconstruction filters.

MODULE V INTRODUCTION TO INFORMATION THEORY

9 Hours

Measure of information - Entropy and properties - Source coding theorem - Channel coding theorem -Discrete memory less channels - Binary Symmetric Channel - Mutual information - Channel capacity -Shannon Hartley law - Shannon Fano algorithm - Huffman Coding - LZ coding.

Further Reading:

Total: 45 Hours

1. Working principle of MODEM. AM /FM broadcasting

Design of AM and FM radio, Television Receivers.

References:

- 1. Simon Haykin, "Communication Systems" John Wiley & Sons, 4th Edition-2016.
- 2. J.G. Proakis, "Digital Communications" McGraw Hill, 5th edition -2007
- 3. B.P. Lathi, "Communication Systems" BS Publication-2004.
- 4. V.Chandrasekar, "Analog communication". Oxford University press-2010 Dr. S. RAMABALAN, M.E., Ph.D.,
- 5. P.Rama Krishna rao, Analog Communication. Tata McGraw-Hill-2011
- 6. Nptel link: https://nptel.ac.in/courses/117/105/117105143/

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PRINCIPAL E.G.S. Pillay Engineering College,

DIGITAL SIGNAL PROCESSING

3

MODULE DISCRETE FOURIER TRANSFORM

9 Hours

Introduction to DFT and IDFT - Properties of DFT - Filtering methods based on DFT - FFT Algorithms -Decimation in time Algorithms, Decimation in frequency Algorithms.

MODULE II

HR FILTER DESIGN

Structures of IIR - Analog filter design - Discrete time IIR filter from analog filter - IIR filter design byImpulse Invariance, Bilinear transformation, Approximation of derivatives - (LPF, HPF, BPF,

BRF) filter design using frequency translation.

MODULE III

FIR FILTER DESIGN

9 Hours

Structures of FR 5 Linear phase FIR filter - Fourier Series - Filter design using windowing techniques(Rectangular Window, Hamming Window, Hanning Window), Frequency sampling techniques.

FINITE WORDLENGTH EFFECTS

9 Hours

Finiteword length effects in digital Filters: Errors, Limit Cycle, Noise Power Spectrum. Fixed point and floating point number representations - Quantization- Truncation and Roundingerrors - Quantization noise - quantization error - Overflowerror - Roundoff noise power - limit cycle oscillations due to product round off and overflow errors.

MODULE V DIGITAL SIGNAL PROCESSORS

9 Hours

Introduction - TMS320c5X Architecture - Features - Addressing Formats - Functional modes -Introduction to Commercial DSP Processors -TMS320C64XX, TMS320 C54X.

Total:

45+15 Hours

Further Reading:

http://www.ti.com/processors/dsp/overview.html

- Spectrum estimation.
- Linear estimation and prediction

References:

- 1. J.G. Proakis and D.G. Manolakis, "Digital Signal Processing Principles, Algorithms and Applications", Pearson Education, New Delhi, PHI. 2003.
- 2. S.K. Mitra, "Digital Signal Processing A Computer Based Approach", McGraw Hill Edu, 2013.
- 3. B. Venkataramani and M.Bhaskar, "Digital Signal Processors Architecture, Programming and Applications" - Tata McGraw - Hill Publishing Company Limited. New Delhi, 2003.
- 4. Robert Schilling & Sandra L.Harris, Introduction to Digital Signal Processing using Matlab", Cengage Learning,2014.
- 5. P. Ramesh Babu, "Digital Signal Processing", Scitech Publications Pvt Ltd, Fourth Edition

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TRANSMISSION LINES AND WAVEGUIDES

 \mathbf{C} 3 3

Entrepreneurst

MODULE I TRANSMISSION LINE THEORY

10 Hours

General solution of transmission line-The two standard forms for voltage and current of the contraction ofalineterminatedbyanimpedance-Physical significance of the equation and the infinite line-Reflection coefficient-Wavelength and velocity of propagation-Waveform distortion-Distortion lesstransmissionline-Thetelephonecable-Inductanceloading of telephone cables - $Input \ impedance \ of \ lossless \ lines \ - \ Reflection \ on \ a \ line \ not \ terminated by Z_0-Transfer impedance-Reflection$ factorandreflectionloss.

MODULE II THE LINE AT RADIO FREQUENCIES Entrepleneur

Standingwavesandstandingwaveratio onaline-Oneoighthwaveline-Quarterwave lineandimpedancematching-Thehalf-waveline-Smith chart - Application of the smith chart - Conversion from impedance to reflection coefficient and vice-versa - Impedance to admittance conversion and vice-versa - Input impedanceof a lossless lineterminatedby an impedance - Single stub matching and double stub matching.

MODULE III FILTERS AND GUIDED WAVES

9 Hours

Constant K Filters - Low pass, High pass band, pass band elimination filters - m -derived sections Waves between parallel planes of perfect conductors - Transverse electric and transverse magnetic waves - Characteristics of TE and TM Transverse electromagnetic waves-Velocities of propagation-Component uniformplanewavesbetweenparallel planes - Attenuation of TE and TM waves in parallel plane guides - Wave impedances.

RECTANGULAR WAVEGUIDES

Transversemagneticwavesinrectangularwave guides – Transverseelectricwavesin rectangular waveguides – Characteristics of TE and TM waves - Cutoff wavelength and phase velocity - Impossibility of TEM waves in waveguides - Dominant mode in rectangularwaveguide- AttenuationofTEandTMmodesin rectangularwaveguide-Wave impedance - Characteristic impedance - Excitation of modes.

CIRCULAR WAVE GUIDESAND RESONATORS MODULE V

9 Hours

Besselfunctions-Solutionoffieldequations in cylindricalco-ordinates-TMandTE waves in circular guides -Wave impedancesand characteristic impedance – Dominant modeincircularwaveguide-Excitationof Microwavecavities-Rectangular cavityresonators-Circularcavityresonator-Semicircularcavityresonator-Qfactorof a cavity resonator for TE101 mode.

Total:

45Hours

Further Reading:

Transmission line equations at radio frequencies - Characteristic impedance of symmetrical networks- Thecirclediagram forthe dissipation less line -composite filters.

References:

- 1. Ryder J. D., "Networks, Lines and Fields", PHI, 2003.
- 2. Jordan E.C. and BalmainK. G., "Electro Magnetic Waves and Radiating System", PHI, 2003.
- 3. Ramo, Whineeryand Van Duzer, "Fields and Waves in Communication Electronics", John Wiley
- 4. David M. Pozar, "Microwave Engineering", 2nd Edition, John Wiley, 1997.

5. DavidK.Cheng. "Fieldand Wavesin Electromagnetism". Pearson Educati Or. 1988. AMABALAN, M.E., Ph.D., PRINCIPAL E.G.S. Pillay Engineering College, Thethi, Nagore - 611 902. Nagapattinam (Dt) Tamil Nadu.

CONTROL SYSTEMS

 \mathbf{C}

MODULE I CONTROL SYSTEMS REPRESENTATION

Introduction to Control systems- Open loop and Closed loop control systems-Transfer function-Modelling of control systems - Mechanical translational and Rotational systems - Electrical systems -Block diagram reduction techniques - Signal flow graph reduction using Masons gain formula. MODULE II

TIME RESPONSE ANALYSIS

Standard test signals- type and order of a system - Time response of First order control systems for step_input-Time response of Second order control systems for step input-Time domain specifications--Steady state error- Controllers-

MODULE III FREQUENCY RESPONSE ANALYSIS

9 Hours

Frequency domain specifications-Frequency response analysis using Polar plot-Bode Plot and Nyquist Plot

STABILITY ANALYSIS OF CONTROL SYSTEMS

9 Hours

Introduction to stability-Stability and the roots of characteristic equation-Routh Hurwitz stability criterionconditionally stable systems-Construction of Boot locus. MODULE V

COMPENSATORS AND STATE SPACE ANALYSIS

9 Hours

Compensators:

Compensators-Lead, Lag and Lag-Lead Compensation - Design of compensator using Bode plot.

State Space Representation:

Introduction to state space analysis-State model of linear systems-Solution of state equation - State transition matrix-Concept of Controllability and Observability

Total:

45Hours

Further Reading:

References:

- 1. Nagrath I.J. and Gopal M., —Control Systems Engineering 1, 5th Edition, New Age International Publishers,
- 2. Norman S. Nise, —Control Systems Engineering!, 6th Edition, Wiley Publishers, 2011
- 3. Nagrath I.J. and Gopal.M, Control Sections Engineering II, 5th Edition, New Age International Publishers,
- 4. Kuo, B.C. Automatic Control Systems. 8th Edition. John Wiley and Sons, New York, 2003

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1904GE551

LIFE SKILLS: APTITUDE - I

MODULE

Classification of numbers - 15 remainders in division may be Square, Square roots -

MODULE II

Definition of Ratio - 1 Ratio - Problems on Problems Rules of Average - Pro assumed mean meil

MODULE III

Introduction Percentage percentage - Percentage percentage- Relation be articles sold at same Co Selling Price.

MODULE IV

Coding using san on R-model - Solvins direction - Problems of notations.

MODULE V

Difference series -Miscellaneous see Problems on letter on letter Odd man rugs

IN TO NUMBER SYSTEM, BASIC SMORTCUTS

MULTIPLICATION, DIVISION

Numbers - Divisibility rules - Finding the Modules digit - Finding higher powers - LCM and HCF Models - Fractions and Digits nots - Shortcuts of addition, multiplication, Division.

OPORTION, AVERAGES

6 Hours

Ratios - Comparison of Ratios - Problems on Ratios - Compound can proportional and Continued Proportion Definition of Average verage - Problems on Weighted Average - Finding average using

, PROFIT AND LOSS

6 Hours

ng a percentage into decimals - Converting a Decimal into a Tractions - Problems on percentages - Problems on Profit and Loss rice and Selling price - Discount and Marked Price - Two different vo different articles sold at same Selling Price - Gain% / Loss% on

ECODING. DIRECTION SENSE

6 Hours

ting using different set of letters - Coding into a number - Problems rawing the paths - Finding the net distance travelled - Finding the lems on shadows - Problems on direction sense using symbols and

ETTER SERIES NUMBER AND LETTER

6 Hours

DD MAN OUT

uares series - Cubes series - Alternate series - Combination series of letters - Definition of Analogy - Problems on number analogy on verbal analogy - Problems on number Odd man out - Problems erbal Odd man out

Further Reading:

Total:

30 Hours

v.ti.com/processors/dsp/overview.html estimation.

imation and prediction

References:

- 1. Arun Shame Hills pub!
- 2. Arun Sharina publication
- 3. R S Agai 2017.
- 4. RS Agrand publications.
- 5. Rajesh V
- 6. B.S. Sijwa edition, A

sare for Quantitative Aptitude for the CAT", 7th edition, McGraw

pare for Logical Reasoning for CAT", 4th edition, McGraw Hills

roach to Logical reasoning", revised edition, S.Chand publication,

Aptitude for Competitive Examinations", revised edition, S.Chand

bjective Arithmetic", 3rd edition, Arihant publication, 2018. , "A New Approach to REASONING Verbal & Non-Verbal" °014.

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	List of Experiments:					
	1. Study of Network Topics					
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	6. Configure a Network	Votte Buring Protocol				
	7. Implementation ::					
	8. Implementation of	1 TOTOCO)			20	
		Decryption				
	9. Configure a Netw y 10. To Create Scenaria tu Ti					
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LABORATORY COURSES

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Professional Elective - I

1903EC004

HSPLAY SYSTEMS

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MODULE I INT

Introduction to displays. Hospithements display technologies. Tecal ssues

MODULE II MOUN HE

Head mounted displays. splays | emitting displays.

MODULE III WO TING On

Operation of TFTs and : S. LCD

MODULE IV Tyn f Disp

Emissive displays, ACT L, Plast performance.

MODULE V Al' 'CATIO'

Types of Displays: 3D. V, LEI

DISPLAY SYSTEMS

9 Hours plays. Display technologies, CRT, Flat panel and advanced days.

SPLAY

9 Hours and greater than 0.5 m diagonal. Low power and light

ON OF DISPLAY

ness. Types of LCD displays.

9 Hours

45 Hours

9 Hours

my and Field emission displays, operating principle and

HSPLAY

9 Hours

Total:

creen.

Further Reading:

1. 5 Communication

2. 12 °C

References:

1. L.W. Mackonal A.C. Low-

2. E.H. Stupp & M Brenne

3. Peter A. Keller, "octronic I" Wiley-Inter scie 2, 1997.

4. Recent literature Display S

lay Systems, Design and Applications, Wiley, 2003.

ojection Displays, Wiley,1999

leasurement: Concepts, Techniques, and Instrumentation,

", Motilal Banarsidass Publishers, ISBN 13: 978-8120810990,

6. M. Hiriyanna, "Essenti

2014

Audit Course

1901MCX03	LUNCH O	MAN TRADITIONAL KNOWLEDGE ommon to All Branches)		L 2	T 0	P 0	- C	
MODULE I INTRO: Culture, civilization, culture Indian Culture, Ancient In-	heritane, configuration of the distribution of	URE characteristics of culture, importance of culturelern India.	re in l	hum	nan	6 Ho	our: ture	S
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 Kapil Kapoor, "Text at "Science in Samskrit". NCERT, "Position paper. S. Narain, "Examination. 	n _t .	ia Tradition",ISBN: 81246033375,2005 Der, ISBN 13: 978-8187276333,2007 Grand Theatre", ISBN 81-7450 494-X,200 Book Depot,1993	51				(a)	
5. Satya Prakash, "Found.6. M. Hiriyanna, "Essenting	11 1/	at India", Vijay Kumar Publisher, 1989						

COMPUTER NETWORKS

L T P C 3 0 0 3

MODULE I INTRODUCTION AND CONCEPTS OF NETWORKS

9 Hours

Networks – Categories of Networks – Network hardware – Network software – Network Architecture – TCP/IP reference models – Network Land technologies - Transmission media.

MODULE II DATA LINK LASTR AND PHYSICAL LAYER

9 Hours

Data link layer: Functionality of data Eak layer- Data link control and protocols – Error Detection and Error Correction - MAC – Ethernet- Products LAN- Broadband wireless – Bluetooth – Data link layer switching – Physical layer: Basis for Can communication- Wireless transmission – Transmission media-Multiplexing- Channel capacity- swift – x

MODULE III NETWORK LO

9 Hours

Network layer – Functionality of new layer- Network addressing- Network routing- Routing algorithms- Internetworking- Quality and provide- Network layer protocols- Switching concepts – Circuit switching – Packet switching- Network layer design issues.

MODULE IV TRANSPORTER

9 Hours

Total: 45 + 15 **Hours**

Functionality of transport layer- There control protocol- Congestion control protocol- Congestion control woidance – User datagram protocol- Delay tolerant networking-

MODULE V APPLICATION OF SECURITY

CURTTY

Applications protocols—Client medican amidel- Network services- DES- RSA- Web security- Recent trends, development and issues

Further Reading:

1. Computer ' - Δ- Tanenbanum- 5th edition

2. Compared the 11pg- A top down approach- Kurose/ Ross- 6th edition

References:

1. Achyut S Godbole. Atult falls at Communications and Networks", Second edition 2011

2. Andrew S. Tannenbaum Derf Wetherall, "Computer Networks" Fifth Edition, Pearson Education 2011

3. Douglas E. Comer. — https://doi.org/10.1001/j.principles, Protocols and Architecturell, Sixth Edition in Education, 2013.

4. Forouzan, "Data Course and Networking", Fifth Edition, TMH 2012.

5. James F. Kurose, Keinh W. Computer Networking: A Top-down Approach, Pearson Education, Limited, sixth e 2012.

6. Larry L. Peterson & Bruce. "Computer Networks – A systems Approach", Fifth Edition, Morgan Kaufmann. 2013

7. William Stallings. — Duter Communications, Tenth Edition, Pearson Education, 2013

E.G.S.PILLAYENGINEERINGCOLLEGE

(Autonomous)

Approved by AICTE, New Delhi| Affiliated to Anna University, Chennai Accredited by NAAC with "A" Grade| Accredited by NBA (CSE, EEE, MECH, ECE, CIVIL, IT)

NAGAPATTINAM—611002



B.E ELECTRONICS AND COMMUNICATION ENGINEERING

Full Time Curriculum and Syllabus

Third Year - Sixth Semester

Course	Course Nome					Maximum Marks			
Code	Course Name	L	T	P	C	CA	ES	Total	
Theory Cours	5e								
1902EC601	Antenna and Waveguide Propagation	2	2	0	3	40	60	100	
1902EC602	VLSI Design	3	0	0	3	40	60	100	
1902EC603	Digital Communication	3	0	0	3	40	60	100	
1901MGX01	HSS Elective I	3	0	0	3	40	60	100	
1903EC030 1903EC025	Open Elective I	3	0	0	3	40	60	100	
1903EC008	Professional Elective – II	3	0	0	3	40	60	100	
Laboratory Co	urse					*			
1902EC651	VLSI Design Laboratory	0	0	2	1	50	50	100	
1902EC652	Analog & Digital Communication Laboratory	0	0	2	1	50	50	100	
1904EC653	Industrial Visit Presentation	0	0	0	1	50	50	100	
1904GE651	Life Skills: Aptitude II & GD	2	0	0	1	100		100	
	Total	19	2	4	22	540	460	1000	

L-Lecture | T-Tutorial | P-Practical | C-Credit | CA -Continuous Assessment | ES-End Semester

Course Code	Course Name		Т	P	C	Maximum Marks				
		L				CA	ES	Total		
	HSS	Elective	e - I		3					
1901MGX01	Total Quality Management	3	0	0	3	40	60	100		
1901MGX02	Project Management and Finance	3	0	0	3	40	60	100		
1901MGX03	Operations Research	3	0	0	3	40	60	100		
1901MGX04	Principles of Management	3	0	0	3	40	60	100		
	Open Elective	- I (Ev	en Sei	meste	er)					
1903EC028	Medical Electronics	3	0	0	3	40	60	100		
1903EC029	High Speed Networks	3	0	0	3	40	60	100		
1903EC030	Generations of Communication Technology.	3	0	0	3	40	60	100		
1903EC031	Optical Networks	3	0	0	3	40	60	100		
1903EC025	Satellite Communication	3	0	0	3	40	60	100		
	Profession	al Elect	tive -	II			·			
1903EC006	Radar and Navigation Aids	3	0	0	3	40	60	100		
1903EC007	Automotive Electronics	3	0	0	3	40	60	100		
1903EC008	Internet of Things	3	0	0	3	40	60	100		
1903EC009	Biomedical Engineering	3	0	0	3	40	60	100		
1903EC010	Information Coding Techniques	3	0	0	3	40	60	100		

ANTENNAS AND WAVE PROPOGATION

L T P C

3 0 0 3

MODULE I FUNDAMENTALS OF RADIATION

9 Hours

Definition of antenna parameters – Gain, Directivity, Effective aperture, Radiation Resistance, Band width, Beam width, Input Impedance. Matching – Baluns, Polarization mismatch, Antenna noise temperature, Radiation from oscillating dipole, Half wave dipole. Folded dipole, Yagi array.

MODULE II

ANTENNA ARRAYS

Enterpreneurship

9 Hours

N element linear array, Pattern multiplication, Broad side and End fire array – Concept of Phased arrays, Adaptive array, Basic principle of antenna Synthesis-Binomial Arrays, Tchebychev polynomial.

MODULE III

APERTURE AND SLOT ANTENNAS

Enterprenewistop

9 Hours

Radiation from rectangular apertures, Uniform and Tapered aperture, Horn antenna, Reflector antenna, Aperture blockage, Feeding structures, Slot antennas, Micro strip antennas – Radiation mechanism – Application, Numerical tool for antenna analysis.

MODULE IV SPECIAL ANTENNAS

9 Hours

Principle of frequency independent antennas –Spiral antenna, Helical antenna, Log periodic. Modern antennas-Reconfigurable antenna, Active antenna, Dielectric antennas, Electronic band gap structure and applications, Antenna Measurements-Test Ranges, Measurement of Gain, Radiation pattern, Polarization, VSWR.

MODULE V

PROPAGATION OF RADIO WAVES

Enterpreneurship

9 Hours

Modes of propagation, Structure of atmosphere, Ground wave propagation, Tropospheric propagation, Duct propagation, Troposcatter propagation, Flat earth and Curved earth, concept Sky wave propagation – Virtual height, critical frequency, Maximum usable frequency – Skip distance, Fading, Multi hop propagation.

Total:

45 Hours

Further Reading:

1. Signal processing in Microwaves.

References:

- John D Kraus, Ronald J Marhefka, Ahmad S Khan, Antennas for All Applications, The McGraw Hill Companies, 3rd Edition, 2010.
- 2 K. D. Prasad, "Antenna & Wave Propagation", SatyaPrakashan, New Delhi, Fourth Edition 2006.
- John D Kraus, "Antenna& Wave Propagation", McGraw Hill, Communications and Networking, Morgan Kaufmann Publishers, an Imprint of Elsevier, 4th Edition, 2008.
- 4 C.A. Balanis, "Antenna Theory Analysis and Design", John Wiley, Fourth Edition. 2016.
- Vijay K Garg, Wireless Communications and Networking, Morgan Kaufmann Publishers, An Imprint of Elsevier, First Edition, 2008.

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VLSI DESIGN

L T P C 3 0 0 3

MODULE I FABRICATION OF CMOS IC AND PHYSICAL DESIGN

9 Hours

An overview of Silicon Semiconductor technology- NMOS fabrication - CMOS fabrication: n-well, P-well- Twin Tub and SOI Process- Layout design rules- Lambda Design Rules Stick Diagrams-VLSI Layout Design - Layout of Basic Structures - CMOS Logic Gates- Implementation of given logic function using CMOS logic

MODULE II MOS CIRCUIT DESIGN PROCESS

9 Hours

Pass Transistor and Transmission Gate Static CMOS design, Pseudo NMOS –dynamic CMOS logic Clocked CMOS logic, Pre charged domino logic- Keeper Circuits - Dual Rail- Cascade Voltage Switch Logic-Circuit Pit Falls

MODULE III CMOS MEMORIES AND CLOCKING

9 Hours

Sequencing Static Circuits Conventional CMOS Latches and Flip-Flops, Class Semi dynamic Flip-Flop (SDFF) –TSPC Latches and FF – Memory architecture- Flash Memory ,CMOS Static RAM- Dynamic RAM and CAM -,CMOS Clocking Styles_

MODULE IV

VLSI SUBSYSTEM DESIGN

9 Hours

CMOS Mux - Equality Detector - Shift and Rotation Operation - Priority encoder- Ripple Carry Adder-Carry Look Ahead Adder - Carry Skip Adder - Carry select and Carry save-Adder - Braun/ Baugh Wooley - Modified Booth Encoded Multiplier.

MODULE V IMPLEMENTATION STRATEGIES

9 Hours

Full custom and Semi custom design, Standard cell design and cell libraries, FPGA building block architectures, FPGA interconnect routing procedures.

Total: 45 Hours

Further Readings:

 Comparison of Logic Styles - Differential and Sense Amplifier Circuits Prescaler - Bit Slice – ALU CMOS Clock Generation and Distributions - BICMOS- FINFET Technology

References:

- 1. John P. Uyemura, "Introduction to VLSI circuits and systems", John Wiley & Sons, 2015
- 2. Neil.H.E Weste David Harris CMOS VLSI Design: A Circuits and Systems Perspective, 4th edition, Pearson Addison Wesley, 2015.
- 3. Kamran Eshraghian, Douglas A. Pucknell, Essentials of VLSI Circuits and Systems Prentice Hall of India, 2015.
- 4. E. Fabricious, Introduction to VLSI Design, 1st edition, McGraw Hill, 2014

5. Keng, Lablebick, "CMOS Digital Integrated Circuits", Tata McGraw Hill, 2014

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DIGITAL COMMUNICATION

L T P C 3 0 - 0 3

MODULE I

DIGITAL PULSE MODULATION

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9 Hours

Review of Sampling, Aliasing and Reconstruction – Quantization: Uniform and Non-uniform quantization – Quantization noise – Commanding of speech signal – Waveform coding: Pulse Code Modulation – Differential pulse code modulation – Adaptive differential pulse code modulation – Delta modulation – Adaptive Delta modulation – Linear Predictive Coding.

MODULE II BASEBAND TRANSMISSION

9 Hours

Digital line encoding techniques: Need for line shaping of signals, Properties of Line codes, Unipolar / Polar RZ & NRZ, Bipolar NRZ, Manchester – Matched filter – Inter Symbol Interference and Nyquist criteria for ISI cancellation – Pulse shaping with raised cosine filter – Correlative level coding – Mary PAM transmission – Optimum linear receivers – Equalization techniques – Eye pattern.

MODULE III ERROR CONTROL CODING TECHNIQUES

9 Hours

Discrete memory less channel – Linear block codes – Hamming codes – Cyclic codes – BCH codes, RS codes, Go lay codes, CRC codes – Convolution codes – State diagram – Code Trellis – Viterbi algorithm for decoding – Problems.

MODULE IV PASSBAND DATA TRANSMISSION TECHNIQUES

9 Hours

Generation, Detection, Representation of signal, Signal constellation diagram, Error probability and Power spectrum of ASK, FSK, BPSK, DPSK, QPSK, MSK, GMSK and QAM coherent schemes – Comparison and BER Analysis.

MODULE V SYNCHRONIZATION AND SPREAD SPECTRUM TECHNIQUES

9 Hours

Importance of Synchronization – Carrier, frame and symbol/Chip synchronization techniques, Spread Spectrum-PN Sequence code and properties – Direct Sequence and Frequency Hopping Spread Spectrum Systems – Processing gain and Jamming Margin.

Total:

45 Hours

Further Reading:

- 1. Mobile radio propagation
- 2. TDMA FDMA CDMA OF DMA.

References:

- 1. Simon Haykin, "Digital Communications", John Wiley, 2015.
- 2. J.G. Proakis, "Digital Communications", McGraw Hill, 5th edition, 2007
- 3. Bernard Sklar, "Digital Communication", 2nd Edition, Pearson Education, 2006.
- 4. H Taub& D L Schilling, "Principles of Communication Systems", 3rd Edition, Tata McGraw Hill, 2008.
- 5. Nptellink: https://onlinecourses.nptel.ac.in/noc20 ee17/course
- 6. https://www.tutorialspoint.com/digital communication/index.htm

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VLSI DESIGN LABORATORY

L T P C 0 0 4 2

List of Experiments:

- 1. Design a Multiplier (4 Bit Min) using HDL. Simulate it using Xilinx/Altera Software and implement by Xilinx/Altera FPGA
- 2. Design an ALU using HDL. Simulate it using Xilinx/Altera Software and implement by Xilinx/Altera FPGA
- Design a Universal Shift Register using HDL. Simulate it using Xilinx/Altera Software and implement by Xilinx/Altera FPGA
- 4. Design Finite State Machine (Moore/Mealy) using HDL. Simulate it using Xilinx/Altera Software and implement by Xilinx/Altera FPGA
- 5. Design a Multiplier (4 Bit Min) using HDL. Simulate it using Xilinx/Altera Software and implement by Xilinx/Altera FPGA
- 6. Design and Simulate a CMOS Inverting Amplifier.
- 7. Design and Simulate basic Common Source, Common Gate and Common Drain Amplifiers
- 8. Design and simulate a CMOS Basic Gates and Flip-Flops
- 9. FPGA Implementation of ALU
- 10. FPGA Implementation of 4 bit adder

Additional Experiments:

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- 1. Designing a CMOS Latch
- 2. Using VHDL design a frequency divider

References:

- 1. E. Fabricious, Introduction to VLSI Design, 1st edition, McGraw Hill, 2014
- 2. Neil.H.EWeste David Harris CMOS VLSI Design: A Circuits and Systems Perspective, 4th edition, Pearson Addison Wesley, 2015
- 3. Kamran Eshraghian, Douglas A. Pucknell, Essentials of VLSI Circuits and Systems Prentice Hall of India, 2015.
- 4. John P.Uyemura, "Introduction to VLSI circuits and systems", John Wiley & Sons, 2015

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ANALOG AND DIGITAL COMMUNICATION LABORATORY

0 0 4 2

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List of Experiments:

Design, Simulate and implement the following,

- 1. Amplitude Modulation.
- 2. Frequency Modulation.
- 3. Pre-emphasis and de-emphasis in FM.
- 4. PAM, PWM and PPM.
- 5. Time Division Multiplexing and Frequency Division Multiplexing.
- 6. Analog Signal Sampling and Reconstruction.
- 7. Pulse Code Modulation.
- 8. Delta Modulation
- 9. Line Coding formats
- 10. Error Control Coding
- 11. ASK, FSK, BPSK, QPSK

Additional Experiments:

- 1. Super heterodyne Receiver
- 2. Simulation of Equalization Techniques

- 1. J.G. Proakis, "Digital Communications", McGraw Hill, 5th edition, 2007
- 2. Simon Haykin, Communication Systems, John Wiley, 2001.
- 3. Jack Quinn, "Digital Data Communication", Prentice Hall; 1st edition,-199)
- 4. P.Michael Fitz, Fundamentals of Communication System, Tata McGraw-Hill -2008.
- 5. P.Rama Krishna rao, Analog Communication, Tata McGraw-Hill -2011

HSS ELECTIVE - I

1901MGX01

TOTAL QUALITY MANAGEMENT

L T P C 3 0 0 3

MODULE I INTRODUCTION

9 Hours

Definition of Quality - Dimensions of Quality - Quality Planning - Quality costs - Analysis Techniques for Quality Costs - Basic concepts of Total Quality Management - Historical Review - Quality Statements - Strategic Planning, Deming Philosophy - Crosby philosophy - Continuous Process Improvement - Juran Trilogy, PDSA Cycle, 5S, Kaizen - Obstacles to TQM Implementation

MODULE II TQM PRINCIPLES

9 Hours

Principles of TQM, Leadership - Concepts - Role of Senior Management - Quality Council, Customer satisfaction - Customer Perception of Quality, Customer Complaints, Service Quality, Customer Retention, Employee Involvement - Motivation, Empowerment, Teams, Recognition and Reward, Performance Appraisal, Benefits - Supplier Partnership - Partnering, sourcing, Supplier Selection, Supplier Rating, Relationship Development, Performance Measures - Basic Concepts, Strategy, Performance Measure

MODULE III STATISTICAL PROCESS CONTROL (SPC)

9 Hours

The seven tools of quality - Statistical Fundamentals - Measures of central Tendency and Dispersion, Population and Sample, Normal Curve, Control Charts for variables X bar and R chart and attributes P, NP, C, and u charts, Industrial Examples, Process capability, Concept of six sigma - New seven Management tools

MODULE IV TOM TOOLS

9 Hours

Benchmarking - Reasons to Benchmark - Benchmarking Process, Quality Function Deployment(QFD)- House of Quality, QFD Process, and Benefits - Taguchi Quality Loss Function - Total Productive Maintenance (TPM) - Concept, Improvement Needs, and FMEA - Stages of FMEA- Casestudies

MODULE V QUALITY SYSTEMS

9 Hours

Concept, Requirements of ISO 9000 and Other Quality Systems - ISO 9000:2000 Quality System - Elements, Implementation of Quality System, Documentation, Quality Auditing, ISO 9000:2005 and 9001:2015, ISO 14000.

Total: 45 Hours

Further Reading:

- 1. Case Study: TQM Quality and Environmental Concepts in real World Applications
- 2. Environment Management system

- 1. Rathakrishnan, Gas Dynamics, 5th edition, PHI Learing Private Limited, 2013.
- 2. N. Gupta and B. Valarmathi, Total Quality Management, Tata McGraw-Hill Publishing Company Pvt. Ltd., New Delhi, 2009.
- 3. S. Kumar, Total Quality Management, Laxmi Publications Ltd. New Delhi, 2006
- 4. P.N. Muherjee, Total Quality Management, Prentice Hall of India, New Delhi, 2006.
- 5. DaleH.Besterfiled, Total Quality Management, Pearson Education Inc., New Delhi, 2003.
- 6. James R. Evans and William M. Lidsay, The Management and Control of Quality, South-Western2002.

OPEN ELECTIVE - II

1903EC030

GENERATIONS OF COMMUNICATION

C

TECHNOLOGY

3 3

MODULE I 1G EVOLUTIONS

9 Hours

History of wireless cellular technology, radio communication, concept of cellular radio system, antenna used in 1G, security measures in 1G, advantages and disadvantages in first generation.

MODULE II 2G EVOLUTIONS

9 Hours

Review of cellular standards, migration and advancement of GSM architecture and CDMA architecture, WLAN - IEEE 802.11 and HIPERLAN, Bluetooth.

MODULE III **3G EVOLUTIONS**

9 Hours

IMT-2000 - W-CDMA, CDMA 2000 - radio & network components, network structure, packet-data transport process flow, Channel Allocation, core network, interference-mitigation techniques, UMTS-services, air interface, network architecture of 3GPP, UTRAN – architecture, High Speed Packet Data-HSDPA, HSUPA.

4G EVOLUTION MODULE IV

9 Hours

Introduction to LTE-A - Requirements and Challenges, network architectures - EPC, E- UTRAN architecture mobility management, resource management, services, channel -logical and transport channel mapping, downlink/uplink data transfer, MAC control element, PDU packet formats, scheduling services, random access procedure.

MODULE V 5G EVOLUTIONS

9 Hours

Introduction, Need for 5G, Evolution of 5G, Comparison of different generations, QoS, 5G network architecture, Future enhancement.

Total:

45 Hours

Further Reading:

- 1. Free space optical communication
- 2. Satellite mobile networks

- 1. Kaveh Pahlavan, "Principles of wireless networks", Prentice-Hall of India, 2008
- 2. A.F.Molisch, Wireless Communications, Wiley, 2005.
- 3. T.S.Rappaport, Wireless Communications: Principles and Practice, Second Edition, PearsonEducation/ Prentice Hall of India, Third Indian Reprint 2003.
- 4. Vijay K.Garg, "Wireless Network Evolution- 2G & 3G" Pearson, 2013.
- 5. K. Daniel Wong, "Fundamentals of Wireless Communication Engineering Technologies" Wiley,2012.
- 6. P.MuthuChidambaraNathan, Wireless Communications, PHI, 2008
- 7. A.Goldsmith, Wireless Communications, Cambridge University Press, 2005.

SATELLITE COMMUNICATION

L T P C

(Open elective)

3 0 0 3

(Common to B.E / B.Tech – CSE, IT & ECE)

MODULE I SATELLITE ORBITS

9 Hours

Introduction - Spectrum allocations for satellite systems -Kepler,,s Laws - orbital parameters - orbital perturbations- Type of orbits - Geo stationary orbits - look angle determination- limits of visibility - eclipse - sub satellite point - sun transit outage

MODULE II SPACE AND EARTH SEGMENT

9 Hours

Spacecraft technology- structure- power supply- attitude and station keeping ,orbit control - thermal control - communication subsystems - telemetry, tracking and command - Transponders Antenna subsystem, Earth station technology -Receive only home TV systems - MATV - CATV

MODULE III SATELLITE ACCESS

9 Hours

Modulation and Multiplexing-Voice, Data, Video, Analog – digital transmission system-Digital video broadcast - multiple accesses: (FDMA, TDMA, CDMA, SDMA-assignment methods) -spread spectrum communication

MODULE IV SATELLITE NAVIGATIONAL SYSTEM

9 Hours

GPS principle of operation, position location determination, principle of GPS receiver and applications-launching procedures - launch vehicles and propulsion.

MODULE V SATELLITE APPLICATIONS

9 Hours

Satellite mobile services – VSAT- Radarsat- Direct Broadcast satellites (DBS) - Direct to home Broadcast (DTH) -Digital audio broadcast (DAB) – World space services, Business TV (BTV) – GRAMSAT - Specialized services: E mail, Video conferencing, Internet- INTELSAT Series- INSAT – INMARSAT. Re

Total:

45 Hours

Further Reading:

1. GIS

- 1.Dennis Roddy, "Satellite Communication", McGraw Hill International, 4th Edition, 2006.
- 2. Wilbur L. Pritchard, Hendri G. Suyderhoud, Robert A. Nelson, "Satellite Communication
- SystemsEngineering", Prentice Hall/Pearson, 2007.
- 3.N.Agarwal, "Design of Geosynchronous Space Craft", Prentice Hall, 1986.
- 4.Bruce R. Elbert, "The Satellite Communication Applications", Hand Book, Artech House BostanLondon, 1997.
- 5.Tri T. Ha, "Digital Satellite Communication", II nd edition, 1990.
- 6. "Elements electronic navigation system", N.S. Nagaraja, 2nd edition Tata McGraw Hill 2000.

PROFESSIONAL ELECTIVE - II

1903EC008

INTERNET OF THINGS

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(Common to B.E / B.Tech – CSE, IT & ECE)

MODULE I Introduction to IoT

9 Hours

3

Defining IoT, Characteristics of IoT, Physical design of IoT, Logical design of IoT, Functional blocks of IoT, Communication models & APIs ,Machine to Machine, Difference between IoT and M2M, Software Defined Network(SDN)

MODULE II Network and Communication Aspects

9 Hours

Wireless medium access issues, MAC protocol survey, Survey routing protocols, Sensor deployment & Node discovery, Data aggregation & dissemination

MODULE III Challenges of IoT

9 Hours

Design challenges, Development challenges, Security challenges, Other challenges

MODULE IV Applications of IoT

9 Hours

Home automation, Industry applications, Surveillance applications, Other IoT applications

MODULE V Developing IoTs

9 Hours

Introduction to Python, Introduction to different IoT tools, Developing applications through IoT tools, Developing sensor based application through embedded system platform, Implementing IoT concepts with python

Total:

45 Hours

Further Reading:

- 1. Cloud Computing
- 2. Dockers and Containers

- 1. Vijay Madisetti, ArshdeepBahga, "Internet of Things: A Hands-On Approach"
- 2. WaltenegusDargie,ChristianPoellabauer, "Fundamentals of Wireless Sensor Networks: Theory and Practice"

INDUSTRIAL VISIT PRESENTATION

TPC

0 0 2 1

GUIDELINE FOR EVALUATION

In order to provide the experiential learning to the students, shall take efforts to arrange at least two industrial visit / field visits in a year. A presentation based on Industrial visits shall be made in this semester and suitable credit may be awarded.

1904GE651

LIFE SKILLS: APTITUDE - II

L T P C 0 0 2 1

MODULE I PARTNERSHIP, MIXTURES AND ALLEGATIONS, PROBLEM ON AGES, SIMPLE INTEREST, COMPOUND INTEREST

9 Hours

Introduction Partnership - Relation between capitals, Period of investments and Shares- Problems on mixtures - Allegation rule - Problems on Allegation - Problems on ages - Definitions Simple Interest - Problems on interest and amount - Problems when rate of interest and time period are numerically equal - Definition and formula for amount in compound interest - Difference between simple interest and compound interest for 2 years on the same principle and time period.

MODULE II BLOOD RELATIONS, , CLOCKS, CALENDARS

9 Hours

Defining the various relations among the members of a family - Solving Blood Relation puzzles - Solving the problems on Blood Relations using symbols and notations - Finding the angle when the time is given - Finding the time when the angle is known - Relation between Angle, Minutes and Hours - Exceptional cases in clocks - Definition of a Leap Year - Finding the number of Odd days - Framing the year code for centuries - Finding the day of any random calendar date .

MODULE III TIME AND DISTANCE, TIME AND WORK

9 Hours

Relation between speed, distance and time - Converting kmph into m/s and vice versa - Problems on average speed - Problems on relative speed - Problems on trains - Problems on boats and streams - Problems on circular tracks - Problems on races - Problems on Unitary method - Relation between Men, Days, Hours and Work - Problems on Man-Day-Hours method - Problems on alternate days - Problems on Pipes and Cisterns.

MODULE IV DATA INTERPRETATION AND DATA SUFFICIENCY

9 Hours

Problems on tabular form - Problems on Line Graphs - Problems on Bar Graphs - Problems on Pie Charts - Different models in Data Sufficiency - Problems on data redundancy.

MODULE V ANALYTICAL AND CRITICAL REASONING

9 Hours

Problems on Linear arrangement - Problems on Circular arrangement - Problems on Double line-up - Problems on Selections - Problems on Comparisons - Finding the Implications for compound statements - Finding the Negations for compound statements- Problems on assumption - Problems on conclusions - Problems on inferences - Problems on strengthening and weakening of arguments .

Total:

45 Hours

- 1. Arun Sharma, "How to Prepare for Quantitative Aptitude for the CAT", 7th edition, McGraw Hills publication, 2016.
- 2. Arun Sharma, "How to Prepare for Logical Reasoning for CAT", 4th edition, McGraw Hills publication, 2017.
- 3. R S Agarwal, "A modern approach to Logical reasoning", revised edition, S.Chand publication, 2017.
- 4. R S Agarwal, "Quantitative Aptitude for Competitive Examinations", revised edition, S.Chand publication, 2017.
- 5. Rajesh Verma, "Fast Track Objective Arithmetic", 3rd edition, Arihant publication, 2018.
- 6. B.S. Sijwalii and InduSijwali, "A New Approach to REASONING Verbal & Non-Verbal", 2nd edition, Arihnat publication, 2014.